

8-bit Microcontrollers

CMOS

F²MC-8FX MB95110M series

MB95117M/F114MS/F114NS/F114JS/F116MS/F116NS/F116JS/
MB95F118MS/F118NS/F118JS/F114MW/F114NW/F114JW/
MB95F116MW/F116NW/F116JW/F118MW/F118NW/F118JW/FV100D-103

■ DESCRIPTION

The MB95110M series is general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers contain a variety of peripheral functions.

Note : F²MC is the abbreviation of FUJITSU Flexible Microcontroller.

■ FEATURES

- F²MC-8FX CPU core
 - Instruction set optimized for controllers
 - Multiplication and division instructions
 - 16-bit arithmetic operations
 - Bit test branch instruction
 - Bit manipulation instructions etc.
- Clock
 - Main clock
 - Main PLL clock
 - Sub clock (for dual clock product)
 - Sub PLL clock (for dual clock product)

(Continued)

Be sure to refer to the "Check Sheet" for the latest cautions on development.

"Check Sheet" is seen at the following support page
URL : <http://edevic.fujitsu.com/micom/en-support/>

"Check Sheet" lists the minimal requirement items to be checked to prevent problems beforehand in system development.

MB95110M Series

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- Timer
 - 8/16-bit compound timer × 2 channels
Can be used to interval timer, PWC timer, PWM timer and input capture.
 - 8/16-bit PPG × 2 channels
 - 16-bit PPG × 1 channel
 - Time-base timer × 1 channel
 - Watch prescaler (for dual clock product) × 1 channel
- LIN-UART × 1 channel
 - LIN function, clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable
 - Full duplex double buffer
- UART/SIO × 1 channel
 - Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable
 - Full duplex double buffer
- I²C* × 1 channel
 - Built-in wake-up function
- External interrupt × 8 channels
 - Interrupt by edge detection (rising, falling, or both edges can be selected)
 - Can be used to recover from low-power consumption (standby) modes.
- 8/10-bit A/D converter × 8 channels
 - 8-bit or 10-bit resolution can be selected
- Low-power consumption (standby) mode
 - Stop mode
 - Sleep mode
 - Watch mode (for dual clock product)
 - Time-base timer mode
- I/O port
 - The number of maximum ports
 - Single clock product : 39 ports
 - Dual clock product : 37 ports
 - Configuration
 - General-purpose I/O ports (N-ch open drain) : 2 ports
 - General-purpose I/O ports (CMOS) : Single clock product : 37 ports
Dual clock product : 35 ports
- Programmable input voltage levels of port
 - Automotive input level / CMOS input level / hysteresis input level
- Dual operation Flash memory
 - Erase/Write and read can be executed in the different bank (Upper Bank/Lower Bank) at the same time.
- Flash memory security function
 - Protects the content of Flash memory (Flash memory device only)

* : Purchase of Fujitsu I²C components conveys a license under the Philips I²C Patent Rights to use, these components in an I²C system provided that the system conforms to the I²C Standard Specification as defined by Philips.

■ MEMORY LINEUP

	Flash memory	RAM
MB95F114MS/F114NS/F114JS	16 Kbytes	512 Kbytes
MB95F114MW/F114NW/F114JW		
MB95F116MS/F116NS/F116JS	32 Kbytes	1 Kbyte
MB95F116MW/F116NW/F116JW		
MB95F118MS/F118NS/F118JS	60 Kbytes	2 Kbytes
MB95F118MW/F118NW/F118JW		

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■ PRODUCT LINEUP

Part number		MB95117M	MB95F114MS/ MB95F116MS/ MB95F118MS	MB95F114NS/ MB95F116NS/ MB95F118NS	MB95F114MW/ MB95F116MW/ MB95F118MW	MB95F114NW/ MB95F116NW/ MB95F118NW	MB95F114JS/ MB95F116JS/ MB95F118JS	MB95F114JW/ MB95F116JW/ MB95F118JW
Parameter								
Type		MASK ROM product	Flash memory product					
ROM capacity*1		48 Kbytes	60 Kbytes (Max)					
RAM capacity*1		2 Kbytes (Max)						
Reset output		Yes/No	Yes				No	
Option*2	Clock system	Selectable single/dual clock*3	Single clock		Dual clock		Single clock	Dual clock
	Low voltage detection reset	Yes / No	No	Yes	No	Yes	Yes	
	Clock supervisor	Yes / No	No				Yes	
CPU functions		Number of basic instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8, and 16 bits Minimum instruction execution time : 61.5 ns (at machine clock frequency 16.25 MHz) Interrupt processing time : 0.6 μs (at machine clock frequency 16.25 MHz)						
Peripheral functions	General purpose I/O ports	• Single clock product : 39 ports (N-ch open drain : 2 ports, CMOS : 37 ports) • Dual clock product : 37 ports (N-ch open drain : 2 ports, CMOS : 35 ports) Programmable input voltage levels of port : Automotive input level / CMOS input level / hysteresis input level						
	Time-base timer (1 channel)	Interrupt cycle : 0.5 ms, 2.1 ms, 8.2 ms, 32.8 ms (at main oscillation clock 4 MHz)						
	Watchdog timer	Reset generated cycle At main oscillation clock 10 MHz : Min 105 ms At sub oscillation clock 32.768 kHz (for dual clock product) : Min 250 ms						
	Wild register	Capable of replacing 3 bytes of ROM data						
	I ² C (1 channel)	Master/slave sending and receiving Bus error function and arbitration function Detecting transmitting direction function Start condition repeated generation and detection functions Built-in wake-up function						
UART/SIO (1 channel)		Data transfer capable in UART/SIO Full duplex double buffer, variable data length (5/6/7/8-bit), built-in baud rate generator NRZ type transfer format, error detected function LSB-first or MSB-first can be selected. Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable						

(Continued)

MB95110M Series

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Part number		MB95117M	MB95F114MS/ MB95F116MS/ MB95F118MS	MB95F114NS/ MB95F116NS/ MB95F118NS	MB95F114MW/ MB95F116MW/ MB95F118MW	MB95F114NW/ MB95F116NW/ MB95F118NW	MB95F114JS/ MB95F116JS/ MB95F118JS	MB95F114JW/ MB95F116JW/ MB95F118JW
Parameter								
Peripheral functions	LIN-UART (1 channel)	Dedicated reload timer allowing a wide range of communication speeds to be set. Full duplex double buffer. Clock asynchronous (UART) or clock synchronous (SIO) serial data transfer capable. LIN functions available as the LIN master or LIN slave.						
	8/10-bit A/D converter (8 channels)	8-bit or 10-bit resolution can be selected.						
	8/16-bit compound timer (2 channels)	Each channel of the timer can be used as "8-bit timer × 2 channels" or "16-bit timer × 1 channel". Built-in timer function, PWC function, PWM function, capture function, and square waveform output Count clock : 7 internal clocks and external clock can be selected						
	16-bit PPG (1 channel)	PWM mode or one-shot mode can be selected. Counter operating clock : 8 selectable clock sources Support for external trigger start						
	8/16-bit PPG (2 channels)	Each channel of the PPG can be used as "8-bit PPG × 2 channels" or "16-bit PPG × 1 channel". Counter operating clock : Eight selectable clock sources						
	Watch counter (for dual clock product)	Count clock : 4 selectable clock sources (125 ms, 250 ms, 500 ms, or 1 s) Counter value can be set from 0 to 63 (Capable of counting for 1minute when selecting clock source 1 second and setting counter value to 60).						
	Watch prescaler (for dual clock product) (1 channel)	4 selectable interval times (125 ms, 250 ms, 500 ms, or 1 s)						
	External interrupt (8 channels)	Interrupt by edge detection (rising, falling, or both edges can be selected.) Can be used to recover from standby modes.						
Flash memory		Supports automatic programming, Embedded Algorithm Write/Erase/Erased-Suspend/Resume commands A flag indicating completion of the algorithm Number of write/erase cycles (Minimum) : 10000 times Data retention time: 20 years Erase can be performed on each block Block protection with external programming voltage Dual operation Flash memory Flash Security Feature for protecting the content of the Flash						
Standby mode		Sleep, stop, watch (for dual clock product) , and time-base timer						

*1 : For ROM capacitance and RAM capacitance, refer to "■ MEMORY LINEUP".

*2 : When the MASK ROM is ordered, please select yes/no for the clock mode, low voltage detection, clock supervisor and reset output.

*3 : Specify clock mode when ordering MASK ROM.

Note : Part number of the evaluation products in MB95110M series is MB95FV100D-103. When using it, the MCU board (MB2146-303A) is required.

MB95110M Series

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■ OSCILLATION STABILIZATION WAIT TIME

The initial value of the main clock oscillation stabilization wait time is fixed to the maximum value. The maximum value is shown as follows.

Oscillation stabilization wait time	Remarks
$(2^{14}-2) / F_{CH}$	Approx. 4.10 ms (at main oscillation clock 4 MHz)

■ PACKAGES AND CORRESPONDING PRODUCTS

Part number Parameter	MB95117M	MB95F114MS/F114NS MB95F114JS MB95F116MS/F116NS MB95F116JS MB95F118MS/F118NS MB95F118JS	MB95F114MW/F114NW MB95F114JW MB95F116MW/F116NW MB95F116JW MB95F118MW/F118NW MB95F118JW	MB95FV100D-103
FPT-52P-M01	○	○	○	×
BGA-224P-M08	×	×	×	○

○ : Available

× : Unavailable

■ DIFFERENCES AMONG PRODUCTS AND NOTES ON SELECTING PRODUCTS

• Notes on Using Evaluation Products

The Evaluation product has not only the functions of the MB95110M series but also those of other products to support software development for multiple series and models of the F²MC-8FX family. The I/O addresses for peripheral resources not used by the MB95110M series are therefore access-barred. Read/write access to these access-barred addresses may cause peripheral resources supposed to be unused to operate, resulting in unexpected malfunctions of hardware or software.

Particularly, do not use word access to odd numbered byte address in the prohibited areas (If these access are used, the address may be read or write unexpectedly) .

Also, as the read values of prohibited addresses on the evaluation product are different to the values on the Flash memory and MASK ROM products, do not use these values in the program.

The functions corresponding to certain bits in single-byte registers may not be supported on some MASK ROM products and Flash memory products. However, reading or writing to these bits will not cause malfunction of the hardware. Also, as the evaluation, Flash memory products are designed to have identical software operation, no particular precautions are required.

• Difference of Memory Spaces

If the amount of memory on the Evaluation product is different from that of the Flash memory or MASK ROM product, carefully check the difference in the amount of memory from the model to be actually used when developing software.

For details of memory space, refer to “■ CPU CORE”.

• Current Consumption

- The current consumption of Flash memory product is typically greater than for MASK ROM product.
- For details of current consumption, refer to “■ ELECTRICAL CHARACTERISTICS”.

• Package

For details of information on each package, refer to “■ PACKAGE AND CORRESPONDING PRODUCTS” and “■ PACKAGE DIMENSIONS”.

• Operating Voltage

The operating voltage are different among the Evaluation, Flash memory, and MASK ROM products.

For details of operating voltage, refer to “■ ELECTRICAL CHARACTERISTICS”

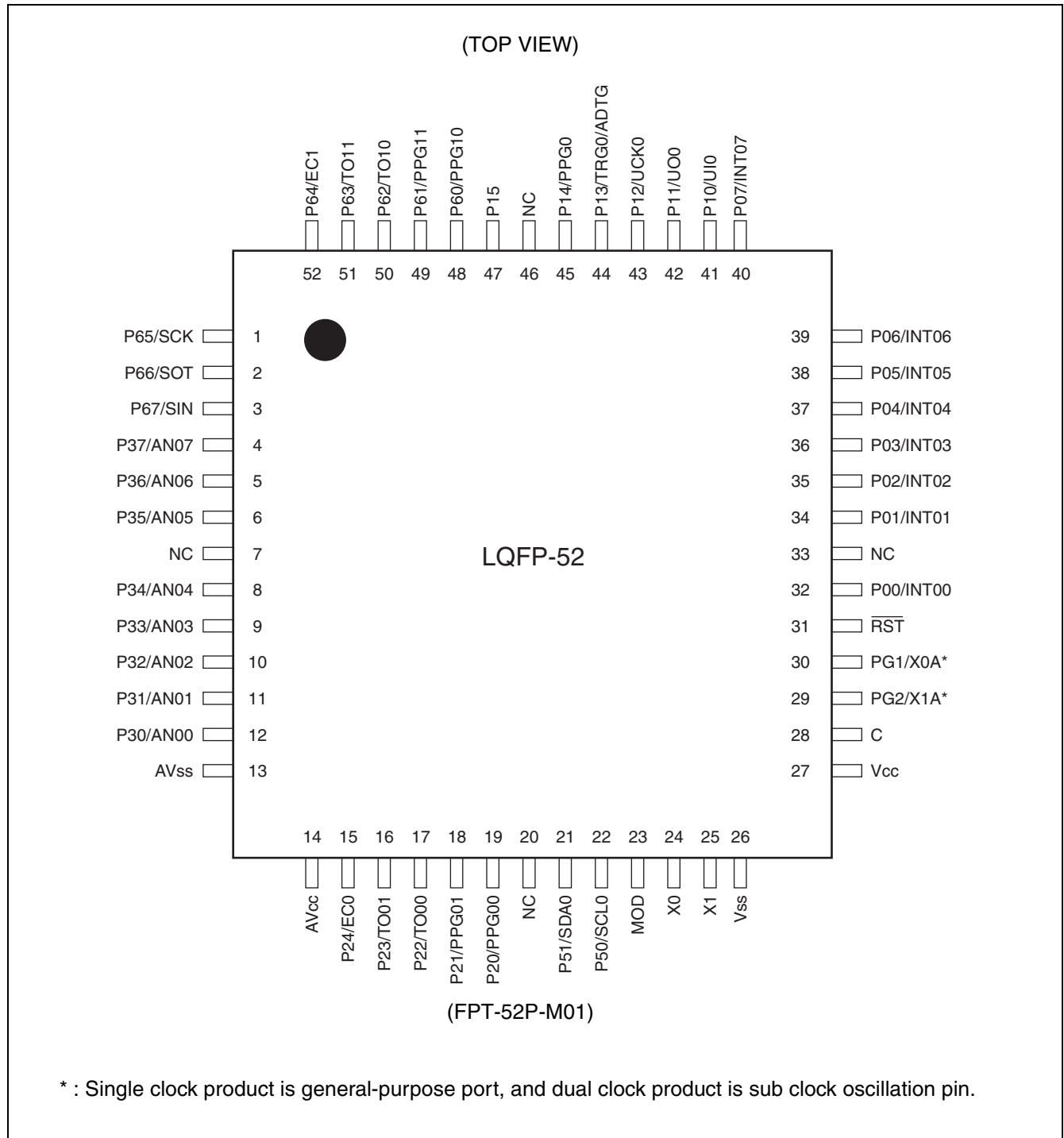
• Difference between $\overline{\text{RST}}$ and MOD Pins

A pull-down resistor is provided for the MOD pin of the MASK ROM product.

MB95110M Series

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■ PIN ASSIGNMENTS



■ PIN DESCRIPTION

Pin no.	Pin name	I/O Circuit type*	Function
1	P65/SCK	K	General-purpose I/O port. The pin is shared with LIN-UART clock I/O.
2	P66/SOT		General-purpose I/O port. The pin is shared with LIN-UART data output.
3	P67/SIN	L	General-purpose I/O port. The pin is shared with LIN-UART data input.
4	P37/AN07	J	General-purpose I/O port. The pins are shared with A/D converter analog input.
5	P36/AN06		
6	P35/AN05		
8	P34/AN04		
9	P33/AN03		
10	P32/AN02		
11	P31/AN01		
12	P30/AN00		
13	AVss	—	A/D converter power supply pin (GND)
14	AVcc	—	A/D converter power supply pin
15	P24/EC0	H	General-purpose I/O port. The pin is shared with 8/16-bit compound timer ch.0 clock input.
16	P23/TO01		General-purpose I/O port.
17	P22/TO00		The pins are shared with 8/16-bit compound timer ch.0 output.
18	P21/PPG01		General-purpose I/O port.
19	P20/PPG00		The pins are shared with 8/16-bit PPG ch.0 output.
21	P51/SDA0	I	General-purpose I/O port. The pin is shared with I ² C ch.0 data I/O.
22	P50/SCL0		General-purpose I/O port. The pin is shared with I ² C ch.0 clock I/O.
23	MOD	B	Operating mode designation pin
24	X0	A	Main clock oscillation input pin
25	X1		Main clock oscillation I/O pin
26	Vss	—	Power supply pin (GND)
27	Vcc	—	Power supply pin
28	C	—	Capacitor connection pin
29	PG2/X1A	H/A	Single clock product is general-purpose port (PG2). Dual clock product is sub clock I/O oscillation pin (32 kHz).
30	PG1/X0A		Single clock product is general-purpose port (PG1). Dual clock product is sub clock input oscillation pin (32 kHz).
31	$\overline{\text{RST}}$	B'	Reset pin

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Pin no.	Pin name	I/O Circuit type*	Function
32	P00/INT00	C	General-purpose I/O port. The pins are shared with external interrupt input. Large current port.
34	P01/INT01		
35	P02/INT02		
36	P03/INT03		
37	P04/INT04		
38	P05/INT05		
39	P06/INT06		
40	P07/INT07		
41	P10/UI0	G	General-purpose I/O port. The pin is shared with UART/SIO ch.0 data input.
42	P11/UO0	H	General-purpose I/O port. The pin is shared with UART/SIO ch.0 data output.
43	P12/UCK0		General-purpose I/O port. The pin is shared with UART/SIO ch.0 clock I/O.
44	P13/TRG0/ ADTG		General-purpose I/O port. The pin is shared with 16-bit PPG ch.0 trigger input (TRG0) and A/D trigger input (ADTG).
45	P14/PPG0		General-purpose I/O port. The pin is shared with 16-bit PPG ch.0 output.
47	P15		General-purpose I/O port.
48	P60/PPG10	K	General-purpose I/O port. The pins are shared with 8/16-bit PPG ch.1 output.
49	P61/PPG11		General-purpose I/O port. The pins are shared with 8/16-bit compound timer ch.1 output.
50	P62/TO10		
51	P63/TO11		General-purpose I/O port. The pin is shared with 8/16-bit compound timer ch.1 clock input.
52	P64/EC1		
7, 20, 33, 46	NC	—	Internally connected pins. Be sure to leave them open.

*: For the I/O circuit type, refer to “■ I/O CIRCUIT TYPE”

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Type	Circuit	Remarks
H	Standby control Pull-up control P-ch P-ch N-ch Digital output Digital output Hysteresis input Automotive input	• CMOS output • Hysteresis input • With pull-up control • Automotive input
I	Standby control N-ch Digital output CMOS input Hysteresis input Automotive input	• N-ch open drain output • CMOS input • Hysteresis input • Automotive input
J	A/D control Standby control Pull-up control P-ch P-ch N-ch Analog input Digital output Digital output Hysteresis input Automotive input	• CMOS output • Hysteresis input • Analog input • With pull-up control • Automotive input
K	Standby control P-ch N-ch Digital output Digital output Hysteresis input Automotive input	• CMOS output • Hysteresis input • Automotive input

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Type	Circuit	Remarks
L	The diagram shows a P-channel MOSFET (P-ch) and an N-channel MOSFET (N-ch) connected to a digital output. A standby control input is connected to the gates of both MOSFETs. The P-ch MOSFET is also connected to a CMOS input, a hysteresis input, and an automotive input.	• CMOS output • CMOS input • Hysteresis input • Automotive input

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■ HANDLING DEVICES

• Preventing Latch-up

Care must be taken to ensure that maximum voltage ratings are not exceeded when they are used.

Latch-up may occur on CMOS ICs if voltage higher than V_{CC} or lower than V_{SS} is applied to input and output pins other than medium- and high-withstand voltage pins or if higher than the rating voltage is applied between V_{CC} pin and V_{SS} pin.

When latch-up occurs, power supply current increases rapidly and might thermally damage elements.

Also, take care to prevent the analog power supply voltage (AV_{CC}) and analog input voltage from exceeding the digital power supply voltage (V_{CC}) when the analog system power supply is turned on or off.

• Stable Supply Voltage

Supply voltage should be stabilized.

A sudden change in power-supply voltage may cause a malfunction even within the guaranteed operating range of the V_{CC} power-supply voltage.

For stabilization, in principle, keep the variation in V_{CC} ripple (p-p value) in a commercial frequency range (50/60 Hz) not to exceed 10% of the standard V_{CC} value and suppress the voltage variation so that the transient variation rate does not exceed 0.1 V/ms during a momentary change such as when the power supply is switched.

• Precautions for Use of External Clock

Even when an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from sub clock mode or stop mode.

PIN CONNECTION

• Treatment of Unused Pin

Leaving unused input pins unconnected can cause abnormal operation or latch-up, leaving to permanent damage. Unused input pins should always be pulled up or down through resistance of at least 2 k Ω . Any unused input/output pins may be set to output mode and left open, or set to input mode and treated the same as unused input pins. If there is unused output pin, make it open.

• Treatment of Power Supply Pins on A/D Converter

Connect to be $AV_{CC} = V_{CC}$ and $AV_{SS} = V_{SS}$ even if the A/D converter is not in use.

Noise riding on the AV_{CC} pin may cause accuracy degradation. So, connect approx. 0.1 μ F ceramic capacitor as a bypass capacitor between AV_{CC} and AV_{SS} pins in the vicinity of this device.

• Power Supply Pins

In products with multiple V_{CC} or V_{SS} pins, the pins of the same potential are internally connected in the device to avoid abnormal operations including latch-up. However, you must connect the pins to external power supply and a ground line to lower the electro-magnetic emission level, to prevent abnormal operation of strobe signals caused by the rise in the ground level, and to conform to the total output current rating.

Moreover, connect the current supply source with the V_{CC} and V_{SS} pins of this device at the low impedance.

It is also advisable to connect a ceramic bypass capacitor of approximately 0.1 μ F between V_{CC} and V_{SS} pins near this device.

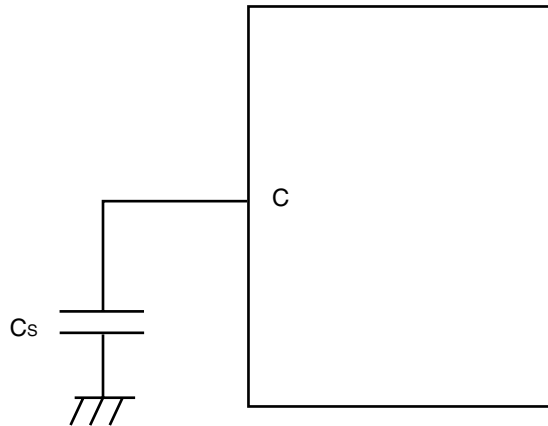
- Mode Pin (MOD)

Connect the MOD pin directly to V_{CC} or V_{SS} pins.

To prevent the device unintentionally entering test mode due to noise, lay out the printed circuit board so as to minimize the distance from the MOD pin to V_{CC} or V_{SS} pins and to provide a low-impedance connection.

Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. A bypass capacitor of V_{CC} pin must have a capacitance value higher than C_s . For connection of smoothing capacitor C_s , refer to the diagram below.

- C pin connection diagram



- NC Pins

Any pins marked "NC" (not connected) must be left open.

- Analog Power Supply

Always set the same potential to AV_{CC} and V_{CC} . When $V_{CC} > AV_{CC}$, the current may flow through the AN00 to AN07 pins.

MB95110M Series

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■ PROGRAMMING FLASH MEMORY MICROCONTROLLERS USING PARALLEL PROGRAMMER

• Supported Parallel Programmers and Adapters

The following table lists supported parallel programmers and adapters.

Package	Applicable adapter model	Parallel programmers
FPT-52P-M01	TEF110-95118PMC	AF9708 (Ver 02.35G or more) AF9709/B (Ver 02.35G or more) AF9723+AF9834 (Ver 02.08E or more)

Note : For information on applicable adapter models and parallel programmers, contact the following:
Flash Support Group, Inc. TEL: +81-53-428-8380

• Sector Configuration

The individual sectors of Flash memory correspond to addresses used for CPU access and programming by the parallel programmer as follows:

• MB95F118MS/F118NS/F118MW/F118NW/F118JS/F118JW (60 Kbytes)

Flash memory	CPU address	Programmer address*	
SA1 (4 Kbytes)	1000 _H	71000 _H	Lower bank
	1FFF _H	71FFF _H	
SA2 (4Kbytes)	2000 _H	72000 _H	
	2FFF _H	72FFF _H	
SA3 (4 Kbytes)	3000 _H	73000 _H	Upper bank
	3FFF _H	73FFF _H	
SA4 (16 Kbytes)	4000 _H	74000 _H	
	7FFF _H	77FFF _H	
SA5 (16 Kbytes)	8000 _H	78000 _H	
	BFFF _H	7BFFF _H	
SA6 (4 Kbytes)	C000 _H	7C000 _H	
	CFFF _H	7CFFF _H	
SA7 (4 Kbytes)	D000 _H	7D000 _H	
	DFFF _H	7DFFF _H	
SA8 (4 Kbytes)	E000 _H	7E000 _H	
	EFFF _H	7EFFF _H	
SA9 (4 Kbytes)	F000 _H	7F000 _H	
	FFFF _H	7FFFF _H	

* : Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.

These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

• Programming Method

- 1) Set the type code of the parallel programmer to “17222”.
- 2) Load program data to programmer addresses 71000_H to 7FFFF_H.

3) Programmed by parallel programmer

• MB95F116MS/F116NS/F116JS/F116MW/F116NW/F116JW (32 Kbytes)

Flash memory	CPU address	Programmer address*
SA5 (16 Kbytes)	8000 _H	78000 _H
	BFFF _H	7BFFF _H
SA6 (4 Kbytes)	C000 _H	7C000 _H
	CFFF _H	7CFFF _H
SA7 (4 Kbytes)	D000 _H	7D000 _H
	DFFF _H	7DFFF _H
SA8 (4 Kbytes)	E000 _H	7E000 _H
	FFFF _H	7EFFF _H
SA9 (4 Kbytes)	F000 _H	7F000 _H
	FFFF _H	7FFFF _H

* : Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.

These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

• Programming Method

- 1) Set the type code of the parallel programmer to "17222".
- 2) Load program data to programmer addresses 78000_H to 7FFFF_H.
- 3) Programmed by parallel programmer

• MB95F114MS/F114NS/F114JS/F114MW/F114NW/F114JW (16 Kbytes)

Flash memory	CPU address	Programmer address*
SA6 (4 Kbytes)	C000 _H	7C000 _H
	CFFF _H	7CFFF _H
SA7 (4 Kbytes)	D000 _H	7D000 _H
	DFFF _H	7DFFF _H
SA8 (4 Kbytes)	E000 _H	7E000 _H
	FFFF _H	7EFFF _H
SA9 (4 Kbytes)	F000 _H	7F000 _H
	FFFF _H	7FFFF _H

* : Programmer addresses are corresponding to CPU addresses, used when the parallel programmer programs data into Flash memory.

These programmer addresses are used for the parallel programmer to program or erase data in Flash memory.

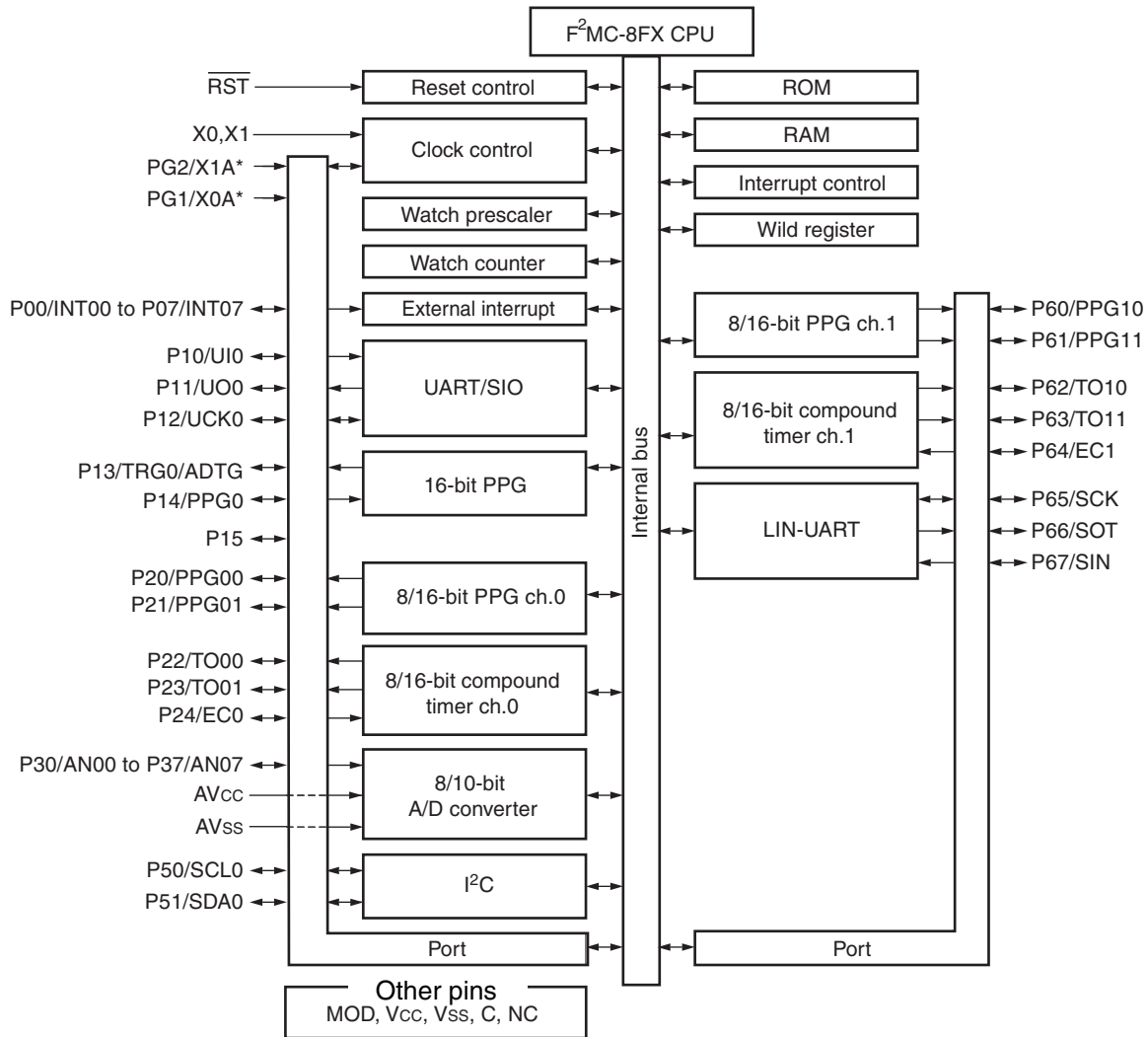
• Programming Method

- 1) Set the type code of the parallel programmer to "17222".
- 2) Load program data to programmer addresses 7C000_H to 7FFFF_H.
- 3) Programmed by parallel programmer

MB95110M Series

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■ BLOCK DIAGRAM



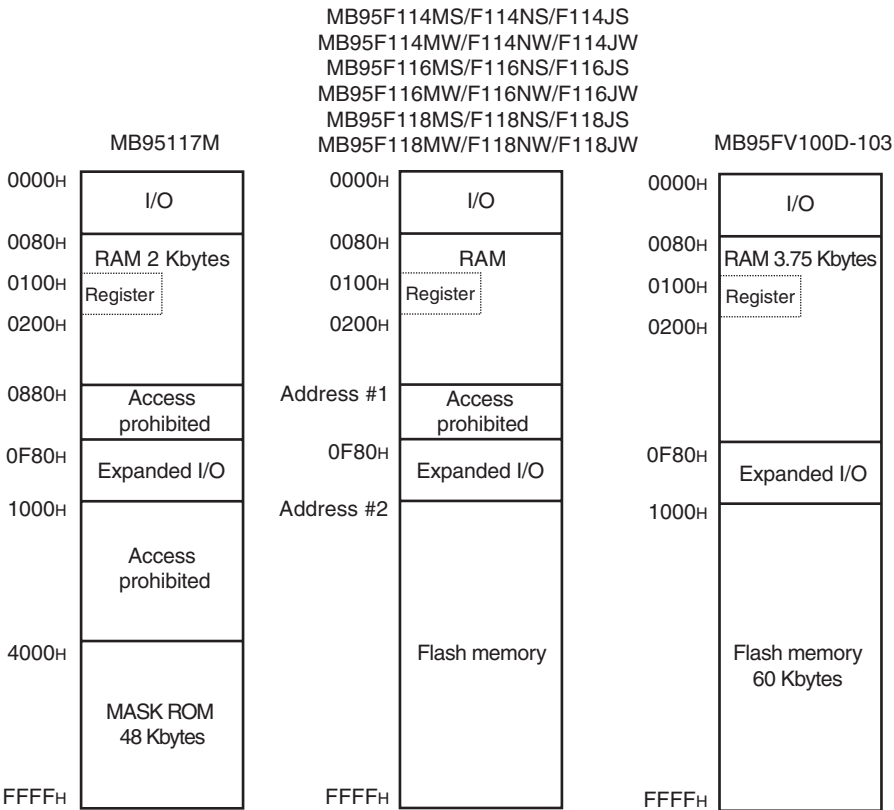
* : Single clock product is a general-purpose port, and dual clock product is a sub clock oscillation pin.

■ CPU CORE

1. Memory space

Memory space of the MB95110M series is 64 Kbytes and consists of I/O area, data area, and program area. The memory space includes special-purpose areas such as the general-purpose registers and vector table. Memory map of the MB95110M series is shown below.

• Memory Map



MB95110M Series

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	Flash memory	RAM	Address #1	Address #2
MB95F114MS/F114NS/F114JS	16 Kbytes	512 bytes	0280 _H	C000 _H
MB95F114MW/F114NW/F114JW				
MB95F116MS/F116NS/F116JS	32 Kbytes	1 Kbyte	0480 _H	8000 _H
MB95F116MW/F116NW/F116JW				
MB95F118MS/F118NS/F118JS	60 Kbytes	2 Kbytes	0880 _H	1000 _H
MB95F118MW/F118NW/F118JW				

2. Register

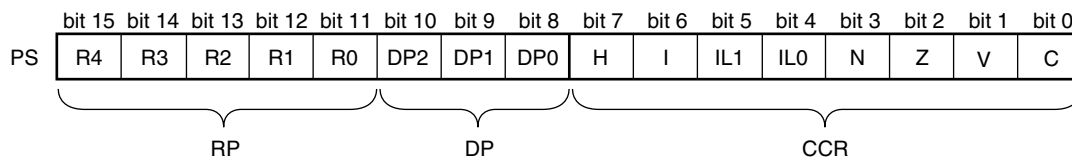
The MB95110M series has two types of registers; dedicated registers in the CPU and general-purpose registers in the memory. The dedicated registers are as follows:

Program counter (PC)	: A 16-bit register to indicate locations where instructions are stored.
Accumulator (A)	: A 16-bit register for temporary storage of arithmetic operations. In the case of an 8-bit data processing instruction, the lower 1 byte is used.
Temporary accumulator (T)	: A 16-bit register which performs arithmetic operations with the accumulator. In the case of an 8-bit data processing instruction, the lower 1 byte is used.
Index register (IX)	: A 16-bit register for index modification.
Extra pointer (EP)	: A 16-bit pointer to point to a memory address.
Stack pointer (SP)	: A 16-bit register to indicate a stack area.
Program status (PS)	: A 16-bit register for storing a register bank pointer, a direct bank pointer, and a condition code register.

	16-bit		Initial Value
PC		: Program counter	FFFD _H
AH	AL	: Accumulator	0000 _H
TH	TL	: Temporary accumulator	0000 _H
IX		: Index register	0000 _H
EP		: Extra pointer	0000 _H
SP		: Stack pointer	0000 _H
PS		: Program status	0030 _H

The PS can further be divided into higher 8 bits for use as a register bank pointer (RP) and a direct bank pointer (DP) and the lower 8 bits for use as a condition code register (CCR) . (Refer to the diagram below.)

• Structure of the program status

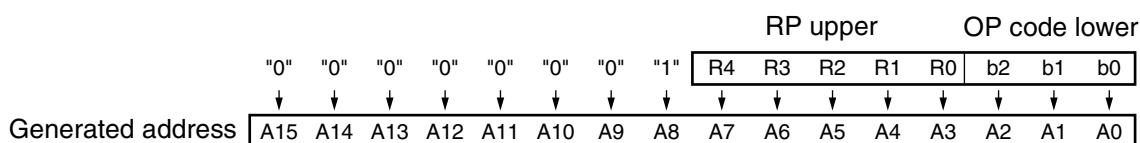


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The RP indicates the address of the register bank currently being used. The relationship between the content of RP and the real address conforms to the conversion rule illustrated below:

- Rule for Conversion of Actual Addresses in the General-purpose Register Area



The DP specifies the area for mapping instructions (16 different instructions such as MOV A, dir) using direct addresses to 0080_H to 00FF_H.

Direct bank pointer (DP2 to DP0)	Specified address area	Mapping area
XXX _B (no effect to mapping)	0000 _H to 007F _H	0000 _H to 007F _H (without mapping)
000 _B (initial value)	0080 _H to 00FF _H	0080 _H to 00FF _H (without mapping)
001 _B		0100 _H to 017F _H
010 _B		0180 _H to 01FF _H
011 _B		0200 _H to 027F _H
100 _B		0280 _H to 02FF _H
101 _B		0300 _H to 037F _H
110 _B		0380 _H to 03FF _H
111 _B		0400 _H to 047F _H

The CCR consists of the bits indicating arithmetic operation results or transfer data contents and the bits that control CPU operations at interrupt.

- H flag : Set to “1” when a carry or a borrow from bit 3 to bit 4 occurs as a result of an arithmetic operation. Cleared to “0” otherwise. This flag is for decimal adjustment instructions.
- I flag : Interrupt is enabled when this flag is set to “1”. Interrupt is disabled when this flag is set to “0”. The flag is set to “0” when reset.
- IL1, IL0 : Indicates the level of the interrupt currently enabled. Processes an interrupt only if its request level is higher than the value indicated by these bits.

IL1	IL0	Interrupt level	Priority
0	0	0	High ↑↓ Low (no interruption)
0	1	1	
1	0	2	
1	1	3	

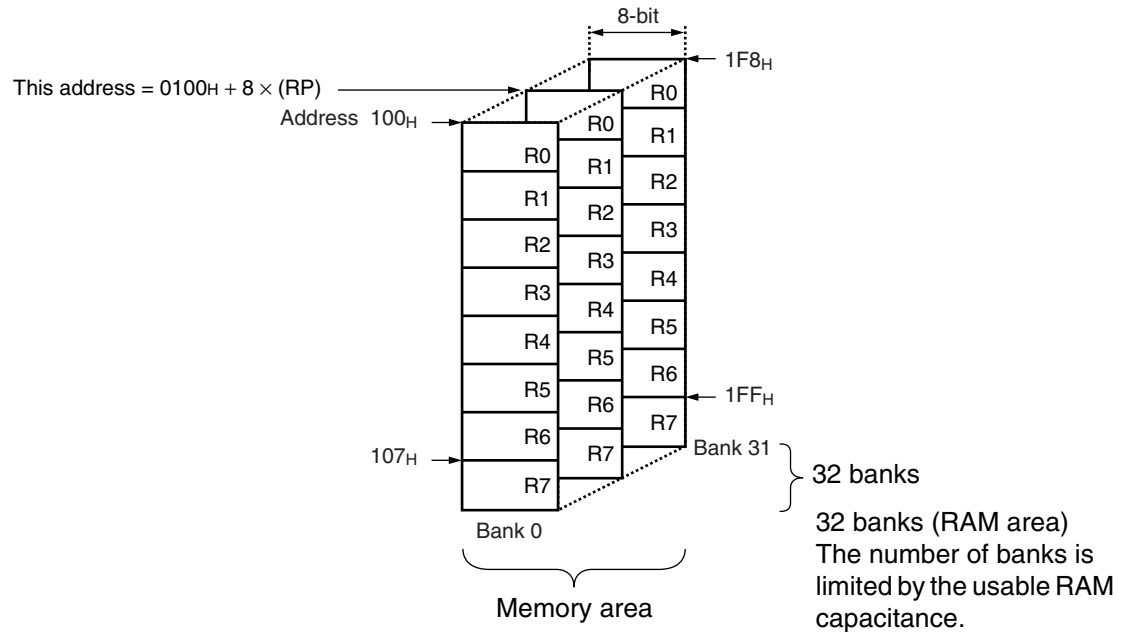
- N flag : Set to “1” if the MSB is set to “1” as the result of an arithmetic operation. Cleared to “0” when the bit is set to “0”.
- Z flag : Set to “1” when an arithmetic operation results in “0”. Cleared to “0” otherwise.
- V flag : Set to “1” if the complement on 2 overflows as a result of an arithmetic operation. Cleared to “0” otherwise.
- C flag : Set to “1” when a carry or a borrow from bit 7 occurs as a result of an arithmetic operation. Cleared to “0” otherwise. Set to the shift-out value in the case of a shift instruction.

The following general-purpose registers are provided:

General-purpose registers: 8-bit data storage registers

The general-purpose registers are 8 bits and located in the register banks on the memory. 1-bank contains 8-register. Up to a total of 32 banks can be used on the MB95110M series. The bank currently in use is specified by the register bank pointer (RP), and the lower 3 bits of OP code indicates the general-purpose register 0 (R0) to general-purpose register 7 (R7).

- Register Bank Configuration



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■ I/O MAP

Address	Register abbreviation	Register name	R/W	Initial value
0000 _H	PDR0	Port 0 data register	R/W	00000000 _B
0001 _H	DDR0	Port 0 direction register	R/W	00000000 _B
0002 _H	PDR1	Port 1 data register	R/W	00000000 _B
0003 _H	DDR1	Port 1 direction register	R/W	00000000 _B
0004 _H	—	(Disabled)	—	—
0005 _H	WATR	Oscillation stabilization wait time setting register	R/W	11111111 _B
0006 _H	PLLC	PLL control register	R/W	00000000 _B
0007 _H	SYCC	System clock control register	R/W	1010X011 _B
0008 _H	STBC	Standby control register	R/W	00000000 _B
0009 _H	RSRR	Reset source register	R/W	XXXXXXXX _B
000A _H	TBTC	Time-base timer control register	R/W	00000000 _B
000B _H	WPCR	Watch prescaler control register	R/W	00000000 _B
000C _H	WDTC	Watchdog timer control register	R/W	00000000 _B
000D _H	—	(Disabled)	—	—
000E _H	PDR2	Port 2 data register	R/W	00000000 _B
000F _H	DDR2	Port 2 direction register	R/W	00000000 _B
0010 _H	PDR3	Port 3 data register	R/W	00000000 _B
0011 _H	DDR3	Port 3 direction register	R/W	00000000 _B
0012 _H , 0013 _H	—	(Disabled)	—	—
0014 _H	PDR5	Port 5 data register	R/W	00000000 _B
0015 _H	DDR5	Port 5 direction register	R/W	00000000 _B
0016 _H	PDR6	Port 6 data register	R/W	00000000 _B
0017 _H	DDR6	Port 6 direction register	R/W	00000000 _B
0018 _H to 0029 _H	—	(Disabled)	—	—
002A _H	PDRG	Port G data register	R/W	00000000 _B
002B _H	DDRG	Port G direction register	R/W	00000000 _B
002C _H	—	(Disabled)	—	—
002D _H	PUL1	Port 1 pull-up register	R/W	00000000 _B
002E _H	PUL2	Port 2 pull-up register	R/W	00000000 _B
002F _H	PUL3	Port 3 pull-up register	R/W	00000000 _B
0030 _H to 0034 _H	—	(Disabled)	—	—

(Continued)

Address	Register abbreviation	Register name	R/W	Initial value
0035 _H	PULG	Port G pull-up register	R/W	00000000 _B
0036 _H	T01CR1	8/16-bit compound timer 01 control status register 1 ch.0	R/W	00000000 _B
0037 _H	T00CR1	8/16-bit compound timer 00 control status register 1 ch.0	R/W	00000000 _B
0038 _H	T11CR1	8/16-bit compound timer 11 control status register 1 ch.1	R/W	00000000 _B
0039 _H	T10CR1	8/16-bit compound timer 10 control status register 1 ch.1	R/W	00000000 _B
003A _H	PC01	8/16-bit PPG1 control register ch.0	R/W	00000000 _B
003B _H	PC00	8/16-bit PPG0 control register ch.0	R/W	00000000 _B
003C _H	PC11	8/16-bit PPG1 control register ch.1	R/W	00000000 _B
003D _H	PC10	8/16-bit PPG0 control register ch.1	R/W	00000000 _B
003E _H to 0041 _H	—	(Disabled)	—	—
0042 _H	PCNTH0	16-bit PPG status control register (Upper byte) ch.0	R/W	00000000 _B
0043 _H	PCNTL0	16-bit PPG status control register (Lower byte) ch.0	R/W	00000000 _B
0044 _H to 0047 _H	—	(Disabled)	—	—
0048 _H	EIC00	External interrupt circuit control register ch.0/ch.1	R/W	00000000 _B
0049 _H	EIC10	External interrupt circuit control register ch.2/ch.3	R/W	00000000 _B
004A _H	EIC20	External interrupt circuit control register ch.4/ch.5	R/W	00000000 _B
004B _H	EIC30	External interrupt circuit control register ch.6/ch.7	R/W	00000000 _B
004C _H to 004F _H	—	(Disabled)	—	—
0050 _H	SCR	LIN-UART serial control register	R/W	00000000 _B
0051 _H	SMR	LIN-UART serial mode register	R/W	00000000 _B
0052 _H	SSR	LIN-UART serial status register	R/W	00001000 _B
0053 _H	RDR/TDR	LIN-UART reception/transmission data register	R/W	00000000 _B
0054 _H	ESCR	LIN-UART extended status control register	R/W	00000100 _B
0055 _H	ECCR	LIN-UART extended communication control register	R/W	000000XX _B
0056 _H	SMC10	UART/SIO serial mode control register 1 ch.0	R/W	00000000 _B
0057 _H	SMC20	UART/SIO serial mode control register 2 ch.0	R/W	00100000 _B
0058 _H	SSR0	UART/SIO serial status register ch.0	R/W	00000001 _B
0059 _H	TDR0	UART/SIO serial output data register ch.0	R/W	00000000 _B
005A _H	RDR0	UART/SIO serial input data register ch.0	R	00000000 _B
005B _H to 005F _H	—	(Disabled)	—	—

(Continued)

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Address	Register abbreviation	Register name	R/W	Initial value
0060 _H	IBCR00	I ² C bus control register 0 ch.0	R/W	00000000 _B
0061 _H	IBCR10	I ² C bus control register 1 ch.0	R/W	00000000 _B
0062 _H	IBSR0	I ² C bus status register ch.0	R	00000000 _B
0063 _H	IDDR0	I ² C data register ch.0	R/W	00000000 _B
0064 _H	IAAR0	I ² C address register ch.0	R/W	00000000 _B
0065 _H	ICCR0	I ² C clock control register ch.0	R/W	00000000 _B
0066 _H to 006B _H	—	(Disabled)	—	—
006C _H	ADC1	8/10-bit A/D converter control register 1	R/W	00000000 _B
006D _H	ADC2	8/10-bit A/D converter control register 2	R/W	00000000 _B
006E _H	ADDH	8/10-bit A/D converter data register (Upper byte)	R/W	00000000 _B
006F _H	ADDL	8/10-bit A/D converter data register (Lower byte)	R/W	00000000 _B
0070 _H	WCSR	Watch counter status register	R/W	00000000 _B
0071 _H	—	(Disabled)	—	—
0072 _H	FSR	Flash memory status register	R/W	000X0000 _B
0073 _H	SWRE0	Flash memory sector writing control register 0	R/W	00000000 _B
0074 _H	SWRE1	Flash memory sector writing control register 1	R/W	00000000 _B
0075 _H	—	(Disabled)	—	—
0076 _H	WREN	Wild register address compare enable register	R/W	00000000 _B
0077 _H	WROR	Wild register data test setting register	R/W	00000000 _B
0078 _H	—	(Mirror of register bank pointer (RP) and direct bank pointer (DP))	—	—
0079 _H	ILR0	Interrupt level setting register 0	R/W	11111111 _B
007A _H	ILR1	Interrupt level setting register 1	R/W	11111111 _B
007B _H	ILR2	Interrupt level setting register 2	R/W	11111111 _B
007C _H	ILR3	Interrupt level setting register 3	R/W	11111111 _B
007D _H	ILR4	Interrupt level setting register 4	R/W	11111111 _B
007E _H	ILR5	Interrupt level setting register 5	R/W	11111111 _B
007F _H	—	(Disabled)	—	—
0F80 _H	WRARH0	Wild register address setting register (Upper byte) ch.0	R/W	00000000 _B
0F81 _H	WRARL0	Wild register address setting register (Lower byte) ch.0	R/W	00000000 _B
0F82 _H	WRDR0	Wild register data setting register ch.0	R/W	00000000 _B
0F83 _H	WRARH1	Wild register address setting register (Upper byte) ch.1	R/W	00000000 _B
0F84 _H	WRARL1	Wild register address setting register (Lower byte) ch.1	R/W	00000000 _B
0F85 _H	WRDR1	Wild register data setting register ch.1	R/W	00000000 _B

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Address	Register abbreviation	Register name	R/W	Initial value
0F86 _H	WRARH2	Wild register address setting register (Upper byte) ch.2	R/W	00000000 _B
0F87 _H	WRARL2	Wild register address setting register (Lower byte) ch.2	R/W	00000000 _B
0F88 _H	WRDR2	Wild register data setting register ch.2	R/W	00000000 _B
0F89 _H to 0F91 _H	—	(Disabled)	—	—
0F92 _H	T01CR0	8/16-bit compound timer 01 control status register 0 ch.0	R/W	00000000 _B
0F93 _H	T00CR0	8/16-bit compound timer 00 control status register 0 ch.0	R/W	00000000 _B
0F94 _H	T01DR	8/16-bit compound timer 01 data register ch.0	R/W	00000000 _B
0F95 _H	T00DR	8/16-bit compound timer 00 data register ch.0	R/W	00000000 _B
0F96 _H	TMCR0	8/16-bit compound timer 00/01 timer mode control register ch.0	R/W	00000000 _B
0F97 _H	T11CR0	8/16-bit compound timer 11 control status register 0 ch.1	R/W	00000000 _B
0F98 _H	T10CR0	8/16-bit compound timer 10 control status register 0 ch.1	R/W	00000000 _B
0F99 _H	T11DR	8/16-bit compound timer 11 data register ch.1	R/W	00000000 _B
0F9A _H	T10DR	8/16-bit compound timer 10 data register ch.1	R/W	00000000 _B
0F9B _H	TMCR1	8/16-bit compound timer 10/11 timer mode control register ch.1	R/W	00000000 _B
0F9C _H	PPS01	8/16-bit PPG1 cycle setting buffer register ch.0	R/W	11111111 _B
0F9D _H	PPS00	8/16-bit PPG0 cycle setting buffer register ch.0	R/W	11111111 _B
0F9E _H	PDS01	8/16-bit PPG1 duty setting buffer register ch.0	R/W	11111111 _B
0F9F _H	PDS00	8/16-bit PPG0 duty setting buffer register ch.0	R/W	11111111 _B
0FA0 _H	PPS11	8/16-bit PPG1 cycle setting buffer register ch.1	R/W	11111111 _B
0FA1 _H	PPS10	8/16-bit PPG0 cycle setting buffer register ch.1	R/W	11111111 _B
0FA2 _H	PDS11	8/16-bit PPG1 duty setting buffer register ch.1	R/W	11111111 _B
0FA3 _H	PDS10	8/16-bit PPG0 duty setting buffer register ch.1	R/W	11111111 _B
0FA4 _H	PPGS	8/16-bit PPG starting register	R/W	00000000 _B
0FA5 _H	REVC	8/16-bit PPG output inversion register	R/W	00000000 _B
0FA6 _H to 0FA9 _H	—	(Disabled)	—	—
0FAA _H	PDCRH0	16-bit PPG down counter register (Upper byte) ch.0	R	00000000 _B
0FAB _H	PDCRL0	16-bit PPG down counter register (Lower byte) ch.0	R	00000000 _B
0FAC _H	PCSRH0	16-bit PPG cycle setting buffer register (Upper byte) ch.0	R/W	11111111 _B
0FAD _H	PCSRL0	16-bit PPG cycle setting buffer register (Lower byte) ch.0	R/W	11111111 _B
0FAE _H	PDUTH0	16-bit PPG duty setting buffer register (Upper byte) ch.0	R/W	11111111 _B
0FAF _H	PDUTL0	16-bit PPG duty setting buffer register (Lower byte) ch.0	R/W	11111111 _B

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Address	Register abbreviation	Register name	R/W	Initial value
0FB0 _H to 0FBB _H	—	(Disabled)	—	—
0FBC _H	BGR1	LIN-UART baud rate generator register 1	R/W	00000000 _B
0FBD _H	BGR0	LIN-UART baud rate generator register 0	R/W	00000000 _B
0FBE _H	PSSR0	UART/SIO dedicated baud rate generator prescaler selection register ch.0	R/W	00000000 _B
0FBF _H	BRSR0	UART/SIO dedicated baud rate generator baud rate setting register ch.0	R/W	00000000 _B
0FC0 _H to 0FC2 _H	—	(Disabled)	—	—
0FC3 _H	AIDRL	A/D input disable register (Lower byte)	R/W	00000000 _B
0FC4 _H to 0FE2 _H	—	(Disabled)	—	—
0FE3 _H	WCDR	Watch counter data register	R/W	00111111 _B
0FE4 _H to 0FE6 _H	—	(Disabled)	—	—
0FE7 _H	ILSR2	Input level select register 2	R/W	00000000 _B
0FE8 _H , 0FE9 _H	—	(Disabled)	—	—
0FEA _H	CSVCR	Clock supervisor control register	R/W	00011100 _B
0FEB _H to 0FED _H	—	(Disabled)	—	—
0FEE _H	ILSR	Input level select register	R/W	00000000 _B
0FEF _H	WICR	Interrupt pin control register	R/W	01000000 _B
0FF0 _H to 0FFF _H	—	(Disabled)	—	—

- R/W access symbols

R/W : Readable/Writable

R : Read only

W : Write only

- Initial value symbols

0 : The initial value of this bit is “0”.

1 : The initial value of this bit is “1”.

X : The initial value of this bit is undefined.

Note : Do not write to the “ (Disabled) ”. Reading the “ (Disabled) ” returns an undefined value.

■ INTERRUPT SOURCE TABLE

Interrupt source	Interrupt request number	Vector table address		Bit name of interrupt level setting register	Same level priority order (atsimultaneous occurrence)
		Upper	Lower		
External interrupt ch.0	IRQ0	FFFA _H	FFFB _H	L00 [1 : 0]	High ↑ ↓ Low
External interrupt ch.4					
External interrupt ch.1	IRQ1	FFF8 _H	FFF9 _H	L01 [1 : 0]	
External interrupt ch.5					
External interrupt ch.2	IRQ2	FFF6 _H	FFF7 _H	L02 [1 : 0]	
External interrupt ch.6					
External interrupt ch.3	IRQ3	FFF4 _H	FFF5 _H	L03 [1 : 0]	
External interrupt ch.7					
UART/SIO ch.0	IRQ4	FFF2 _H	FFF3 _H	L04 [1 : 0]	
8/16-bit compound timer ch.0 (Lower)	IRQ5	FFF0 _H	FFF1 _H	L05 [1 : 0]	
8/16-bit compound timer ch.0 (Upper)	IRQ6	FFEE _H	FFEF _H	L06 [1 : 0]	
LIN-UART (reception)	IRQ7	FFEC _H	FFED _H	L07 [1 : 0]	
LIN-UART (transmission)	IRQ8	FFEA _H	FFEB _H	L08 [1 : 0]	
8/16-bit PPG ch.1 (Lower)	IRQ9	FFE8 _H	FFE9 _H	L09 [1 : 0]	
8/16-bit PPG ch.1 (Upper)	IRQ10	FFE6 _H	FFE7 _H	L10 [1 : 0]	
(Unused)	IRQ11	FFE4 _H	FFE5 _H	L11 [1 : 0]	
8/16-bit PPG ch.0 (Upper)	IRQ12	FFE2 _H	FFE3 _H	L12 [1 : 0]	
8/16-bit PPG ch.0 (Lower)	IRQ13	FFE0 _H	FFE1 _H	L13 [1 : 0]	
8/16-bit compound timer ch.1 (Upper)	IRQ14	FFDE _H	FFDF _H	L14 [1 : 0]	
16-bit PPG ch.0	IRQ15	FFDC _H	FFDD _H	L15 [1 : 0]	
I ² C ch.0	IRQ16	FFDA _H	FFDB _H	L16 [1 : 0]	
(Unused)	IRQ17	FFD8 _H	FFD9 _H	L17 [1 : 0]	
8/10-bit A/D converter	IRQ18	FFD6 _H	FFD7 _H	L18 [1 : 0]	
Time-base timer	IRQ19	FFD4 _H	FFD5 _H	L19 [1 : 0]	
Watch timer/Watch counter	IRQ20	FFD2 _H	FFD3 _H	L20 [1 : 0]	
(Unused)	IRQ21	FFD0 _H	FFD1 _H	L21 [1 : 0]	
8/16-bit compound timer ch.1 (Lower)	IRQ22	FFCE _H	FFCF _H	L22 [1 : 0]	
Flash memory	IRQ23	FFCC _H	FFCD _H	L23 [1 : 0]	

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■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	V _{CC} AV _{CC}	V _{SS} – 0.3	V _{SS} + 6.0	V	*2
Input voltage*1	V _I	V _{SS} – 0.3	V _{SS} + 6.0	V	*3
Output voltage*1	V _O	V _{SS} – 0.3	V _{SS} + 6.0	V	*3
Maximum clamp current	I _{CLAMP}	– 2.0	+ 2.0	mA	Applicable to pins*4
Total maximum clamp current	Σ I _{CLAMP}	—	20	mA	Applicable to pins*4
“L” level maximum output current	I _{OL1}	—	15	mA	Other than P00 to P07
	I _{OL2}		15		P00 to P07
“L” level average current	I _{OLAV1}	—	4	mA	Other than P00 to P07 Average output current = operating current × operating ratio (1 pin)
	I _{OLAV2}		12		P00 to P07 Average output current = operating current × operating ratio (1 pin)
“L” level total maximum output current	ΣI _{OL}	—	100	mA	
“L” level total average output current	ΣI _{OLAV}	—	50	mA	Total average output current = operating current × operating ratio (Total of pins)
“H” level maximum output current	I _{OH1}	—	– 15	mA	Other than P00 to P07
	I _{OH2}		– 15		P00 to P07
“H” level average current	I _{OHAV1}	—	– 4	mA	Other than P00 to P07 Average output current = operating current × operating ratio (1 pin)
	I _{OHAV2}		– 8		P00 to P07 Average output current = operating current × operating ratio (1 pin)
“H” level total maximum output current	ΣI _{OH}	—	– 100	mA	
“H” level total average output current	ΣI _{OHAV}	—	– 50	mA	Total average output current = operating current × operating ratio (Total of pins)

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Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power consumption	Pd	—	320	mW	
Operating temperature	T _A	− 40	+ 85	°C	
Storage temperature	T _{stg}	− 55	+ 150	°C	

*1 : The parameter is based on $AV_{SS} = V_{SS} = 0.0$ V.

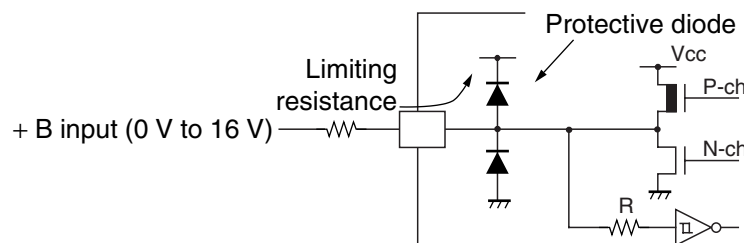
*2 : Apply equal potential to AV_{CC} and V_{CC} .

*3 : V_I and V_O should not exceed $V_{CC} + 0.3$ V. V_I must not exceed the rating voltage. However, if the maximum current to/from an input is limited by some means with external components, the I_{CLAMP} rating supersedes the V_I rating.

*4 : Applicable to pins : P00 to P07, P10 to P15, P20 to P24, P30 to P37, P60 to P67

- Use within recommended operating conditions.
- Use at DC voltage (current).
- +B signal is an input signal that exceeds V_{CC} voltage. The + B signal should always be applied a limiting resistance placed between the + B signal and the microcontroller.
- The value of the limiting resistance should be set so that when the + B signal is applied the input current to the microcontroller pin does not exceed rated values, either instantaneously or for prolonged periods.
- Note that when the microcontroller drive current is low, such as in the power saving modes, the +B input potential may pass through the protective diode and increase the potential at the V_{CC} pin, and this affects other devices.
- Note that if the + B signal is inputted when the microcontroller power supply is off (not fixed at 0 V), the power supply is provided from the pins, so that incomplete operation may result.
- Note that if the + B input is applied during power-on, the power supply is provided from the pins and the resulting power supply voltage may not be sufficient to operate the power-on reset.
- Care must be taken not to leave the + B input pin open.
- Sample recommended circuits :

• Input/Output Equivalent circuits



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

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2. Recommended Operating Conditions

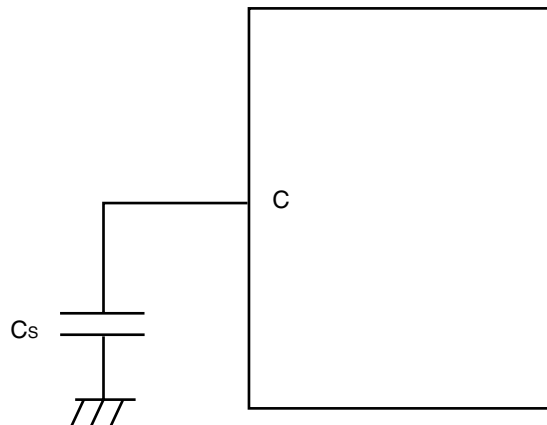
(AVss = Vss = 0.0 V)

Parameter	Symbol	Conditions	Value		Unit	Remarks	
			Min	Max			
Power supply voltage	V _{CC} , AV _{CC}	—	2.42*1	5.5	V	In normal operation	Other than MB95FV100D-103
			2.3	5.5	V	Hold condition in Stop mode	
			2.7	5.5	V	In normal operation	MB95FV100D-103
			2.3	5.5	V	Hold condition in Stop mode	
Smoothing capacitor	C _S		0.1	1.0	μF	*2	
Operating temperature	T _A		− 40	+ 85	°C	Other than MB95FV100D-103	
			+ 5	+ 35	°C	MB95FV100D-103	

*1 : The value is 2.88 V when the low voltage detection reset is used. The device operates normally during the time between 2.88 V and low voltage detection, and between release voltage and 2.88 V.

*2 : Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. A bypass capacitor of V_{CC} pin must have a capacitance value higher than C_s. For connection of smoothing capacitor C_s, refer to the diagram below.

- C pin connection diagram



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

3. DC Characteristics

($V_{CC} = AV_{CC} = 5.0\text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
“H” level input voltage	V_{IH1}	P10, P67	*1	0.7 V_{CC}	—	$V_{CC} + 0.3$	V	At selecting of CMOS input level
	V_{IH2}	P50, P51	*1	0.7 V_{CC}	—	$V_{SS} + 5.5$	V	At selecting of CMOS input level
	V_{IHA}	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P50, P51, P60 to P67, PG1*2, PG2*2	—	0.8 V_{CC}	—	$V_{CC} + 0.3$	V	Pin input at selecting of Automotive input level
	V_{IHS1}	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P60 to P67, PG1*2, PG2*2	*1	0.8 V_{CC}	—	$V_{CC} + 0.3$	V	Hysteresis input
	V_{IHS2}	P50, P51	*1	0.8 V_{CC}	—	$V_{SS} + 5.5$	V	Hysteresis input
	V_{IHM}	$\overline{\text{RST}}$, MOD	—	0.7 V_{CC}	—	$V_{CC} + 0.3$	V	CMOS input (Flash memory product)
			—	0.8 V_{CC}	—	$V_{CC} + 0.3$	V	Hysteresis input (MASK ROM product)
“L” level input voltage	V_{IL}	P10, P50, P51, P67	*1	$V_{SS} - 0.3$	—	0.3 V_{CC}	V	At selecting of CMOS input level
	V_{ILA}	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P50, P51, P60 to P67, PG1*2, PG2*2	—	$V_{SS} - 0.3$	—	0.5 V_{CC}	V	Pin input at selecting of Automotive input level
	V_{ILS}	P00 to P07, P10 to P15, P20 to P24, P30 to P37, P50, P51, P60 to P67, PG1*2, PG2*2	*1	$V_{SS} - 0.3$	—	0.2 V_{CC}	V	Hysteresis input
	V_{ILM}	$\overline{\text{RST}}$, MOD	—	$V_{SS} - 0.3$	—	0.3 V_{CC}	V	CMOS input (Flash memory product)
			—	$V_{SS} - 0.3$	—	0.2 V_{CC}	V	Hysteresis input (MASK ROM product)

(Continued)

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($V_{CC} = AV_{CC} = 5.0\text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Open-drain output application voltage	V_D	P50, P51	—	$V_{SS} - 0.3$	—	$V_{SS} + 5.5$	V	
“H” level output voltage	V_{OH1}	Output pin other than P00 to P07	$I_{OH} = -4.0\text{ mA}$	$V_{CC} - 0.5$	—	—	V	
	V_{OH2}	P00 to P07	$I_{OH} = -8.0\text{ mA}$	$V_{CC} - 0.5$	—	—	V	
“L” level output voltage	V_{OL1}	Output pin other than P00 to P07	$I_{OL} = 4.0\text{ mA}$	—	—	0.4	V	
	V_{OL2}	P00 to P07	$I_{OL} = 12\text{ mA}$	—	—	0.4	V	
Input leakage current (Hi-Z output leakage current)	I_{LI}	Port other than P50, P51	$0.0\text{ V} < V_I < V_{CC}$	-5	—	+5	μA	When the pull-up prohibition setting
Open-drain output leakage current	I_{LIOD}	P50, P51	$0.0\text{ V} < V_I < V_{SS} + 5.5\text{ V}$	—	—	5	μA	
Pull-up resistor	R_{PULL}	P10 to P15, P20 to P24, P30 to P37, PG1*2, PG2*2	$V_I = 0.0\text{ V}$	25	50	100	$k\Omega$	When the pull-up permission setting
Pull-down resistor	R_{MOD}	MOD	$V_I = V_{CC}$	25	50	100	$k\Omega$	MASK ROM product
Input capacitance	C_{IN}	Other than AV_{CC} , AV_{SS} , V_{CC} , V_{SS}	$f = 1\text{ MHz}$	—	5	15	pF	
Power supply current*3	I_{CC}	V_{CC} (External clock operation)	$V_{CC} = 5.5\text{ V}$ $F_{CH} = 20\text{ MHz}$ $F_{MP} = 10\text{ MHz}$ Main clock mode (divided by 2)	—	9.5	12.5	mA	Flash memory product (at other than Flash memory writing and erasing)
				—	30	35	mA	Flash memory product (at Flash memory writing and erasing)
				—	7.2	9.5	mA	MASK ROM product

(Continued)

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($V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+85 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current*3	I _{CC}	V _{CC} (External clock operation)	V _{CC} = 5.5 V F _{CH} = 32 MHz F _{MP} = 16 MHz Main clock mode (divided by 2)	—	15.2	20.0	mA	Flash memory product (at other than Flash memory writing and erasing)
				—	35.7	42.5	mA	Flash memory product (at Flash memory writing and erasing)
				—	11.6	15.2	mA	MASK ROM product
	I _{CCS}		V _{CC} = 5.5 V F _{CH} = 20 MHz F _{MP} = 10 MHz Main sleep mode (divided by 2)	—	4.5	7.5	mA	
			V _{CC} = 5.5 V F _{CH} = 32 MHz F _{MP} = 16 MHz Main sleep mode (divided by 2)	—	7.2	12.0	mA	
	I _{CCCL}		V _{CC} = 5.5 V F _{CL} = 32 kHz F _{MPL} = 16 kHz Sub clock mode (divided by 2) , T _A = + 25 °C	—	45	100	μA	
	I _{CCCLS}		V _{CC} = 5.5 V F _{CL} = 32 kHz F _{MPL} = 16 kHz Sub sleep mode (divided by 2) , T _A = + 25 °C	—	10	81	μA	
	I _{CCCT}		V _{CC} = 5.5 V F _{CL} = 32 kHz Watch mode Main stop mode T _A = + 25 °C	—	4.6	27	μA	
	I _{CCMPLL}		V _{CC} = 5.5 V F _{CH} = 4 MHz F _{MP} = 10 MHz Main PLL mode (multiplied by 2.5)	—	9.3	12.5	mA	Flash memory product
				—	7.0	9.5	mA	MASK ROM product
			V _{CC} = 5.5 V F _{CH} = 6.4 MHz F _{MP} = 16 MHz Main PLL mode (multiplied by 2.5)	—	14.9	20.0	mA	Flash memory product
				—	11.2	15.2	mA	MASK ROM product

(Continued)

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(Continued)

($V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+85 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current*3	I_{CCSPLL}	V_{CC} (External clock operation)	$V_{CC} = 5.5 \text{ V}$ $F_{CL} = 32 \text{ kHz}$ $F_{MPL} = 128 \text{ kHz}$ Sub PLL mode (multiplied by 4) $T_A = +25 \text{ }^{\circ}\text{C}$	—	160	400	μA	
	I_{CTS}		$V_{CC} = 5.5 \text{ V}$ $F_{CH} = 10 \text{ MHz}$ Time-base timer mode $T_A = +25 \text{ }^{\circ}\text{C}$	—	0.15	1.10	mA	
	I_{CCH}		$V_{CC} = 5.5 \text{ V}$ Sub stop mode $T_A = +25 \text{ }^{\circ}\text{C}$	—	5	20	μA	Main stop mode for single clock product
	I_{LVD}	V_{CC}	Current consumption for low voltage detection circuit only	—	38	50	μA	
	I_{CSV}		At oscillating 100 kHz current consumption of built-in CR oscillator	—	20	36	μA	
	I_A	AV_{CC}	$V_{CC} = 5.5 \text{ V}$ $F_{CH} = 16 \text{ MHz}$ At operating of A/D conversion	—	2.4	4.7	mA	
	I_{AH}		$V_{CC} = 5.5 \text{ V}$ $F_{CH} = 16 \text{ MHz}$ At stopping A/D conversion $T_A = +25 \text{ }^{\circ}\text{C}$	—	1	5	μA	

*1 : P10, P50, P51, and P67 can switch the input level to either the "CMOS input level" or "hysteresis input level". The switching of the input level can be set by the input level selection register (ILSR).

*2 : Single clock products only

*3 : • The power-supply current is determined by the external clock. When both low voltage detection option and clock supervisor are selected, the power-supply current will be a value of adding current consumption of the low voltage detection circuit (I_{LVD}) and current consumption of built-in CR oscillator (I_{CSV}) to the specified value.
• Refer to "4. AC Characteristics (1) Clock Timing" for F_{CH} and F_{CL} .
• Refer to "4. AC Characteristics (2) Source Clock/Machine Clock" for F_{MP} and F_{MPL} .

4. AC Characteristics

(1) Clock Timing

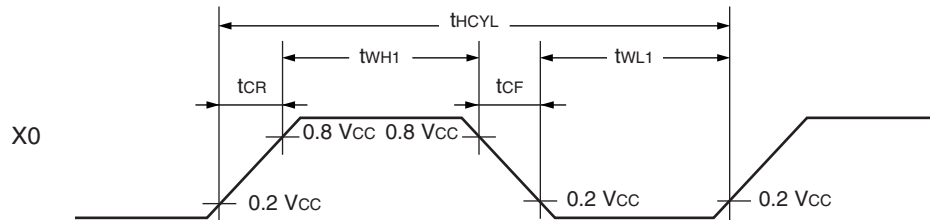
(V_{CC} = 2.42 V to 5.5 V, AV_{SS} = V_{SS} = 0.0 V, T_A = - 40 °C to + 85 °C)

Parameter	Sym- bol	Pin name	Condi- tions	Value			Unit	Remarks
				Min	Typ	Max		
Clock frequency	F _{CH}	X0, X1	—	1.00	—	16.25	MHz	When using main oscillation circuit
				1.00	—	32.50	MHz	When using external clock
				3.00	—	10.00	MHz	Main PLL multiplied by 1
				3.00	—	8.13	MHz	Main PLL multiplied by 2
				3.00	—	6.50	MHz	Main PLL multiplied by 2.5
				3.00	—	4.06	MHz	Main PLL multiplied by 4
	F _{CL}	X0A, X1A		—	32.768	—	kHz	When using sub oscillation circuit
				—	32.768	—	kHz	When using sub PLL V _{CC} = 2.3 V to 3.6 V
Clock cycle time	t _{H CYL}	X0, X1		61.5	—	1000	ns	When using main oscillation circuit
				30.8	—	1000	ns	When using external clock
	t _{L CYL}	X0A, X1A		—	30.5	—	μs	When using sub oscillation circuit
Input clock pulse width	t _{WH1} t _{WL1}	X0		61.5	—	—	ns	When using external clock Duty ratio is about 30% to 70%.
	t _{WH2} t _{WL2}	X0A		—	15.2	—	μs	
Input clock rise time and fall time	t _{CR} t _{CF}	X0, X0A		—	—	5	ns	When using external clock

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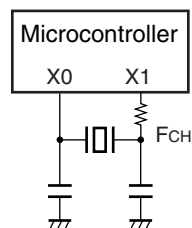
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- Input wave form for using external clock (main clock)

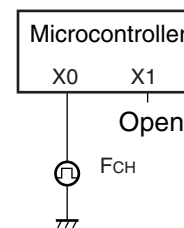


- Figure of main clock input port external connection

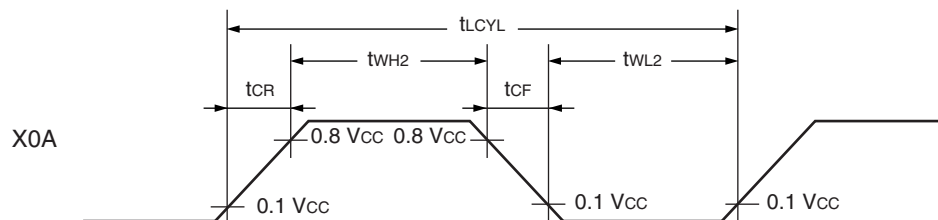
When using a crystal or ceramic oscillator



When using external clock

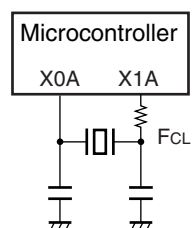


- Input wave form for using external clock (sub clock)

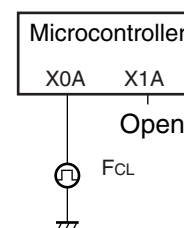


- Figure of sub clock input port external connection

When using a crystal or ceramic oscillator



When using external clock



(2) Source Clock/Machine Clock

(V_{CC} = 5.0 V ± 10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to +85 °C)

Parameter	Symbol	Conditions	Value			Unit	Remarks
			Min	Typ	Max		
Source clock cycle time*1 (Clock before setting division)	t _{SCLK}	—	61.5	—	2000	ns	When using main clock Min : F _{CH} = 8.125 MHz, PLL multiplied by 2 Max : F _{CH} = 1 MHz, divided by 2
			7.6	—	61.0	μs	When using sub clock Min : F _{CL} = 32 kHz, PLL multiplied by 4 Max : F _{CL} = 32 kHz, divided by 2
Source clock frequency	F _{SP}	—	0.50	—	16.25	MHz	When using main clock
	F _{SPL}		16.384	—	131.072	kHz	When using sub clock
Machine clock cycle time*2 (Minimum instruction execution time)	t _{MCLK}	—	61.5	—	32000	ns	When using main clock Min : F _{SP} = 16.25 MHz, no division Max : F _{SP} = 0.5 MHz, divided by 16
			7.6	—	976.5	μs	When using sub clock Min : F _{SPL} = 131 kHz, no division Max : F _{SPL} = 16 kHz, divided by 16
Machine clock frequency	F _{MP}	—	0.031	—	16.250	MHz	When using main clock
	F _{MPL}		1.024	—	131.072	kHz	When using sub clock

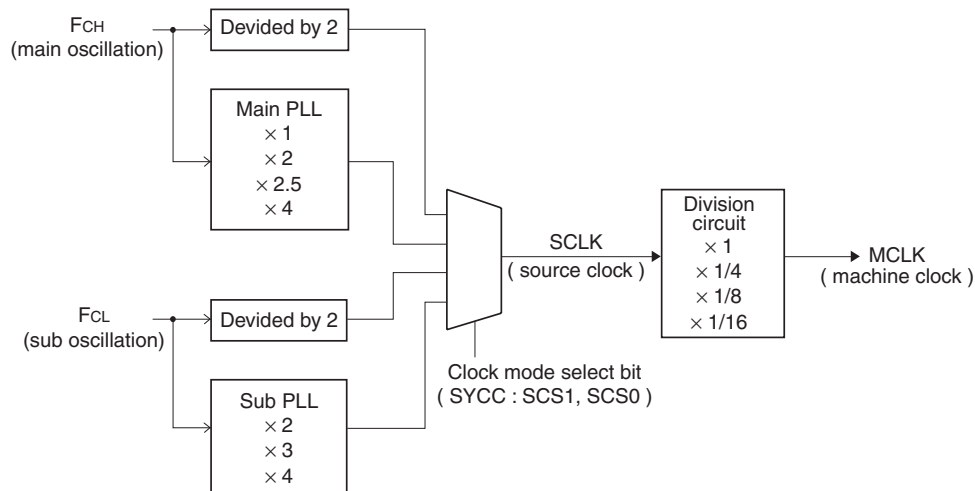
*1 : Clock before setting division due to machine clock division ratio selection bit (SYCC : DIV1 and DIV0) . This source clock is divided by the machine clock division ratio selection bit (SYCC : DIV1 and DIV0) , and it becomes the machine clock. Further, the source clock can be selected as follows.

- Main clock divided by 2
- PLL multiplication of main clock (select from 1, 2, 2.5, 4 multiplication)
- Sub clock divided by 2
- PLL multiplication of sub clock (select from 2, 3, 4 multiplication)

*2 : Operation clock of the microcontroller. Machine clock can be selected as follows.

- Source clock (no division)
- Source clock divided by 4
- Source clock divided by 8
- Source clock divided by 16

• Outline of clock generation block

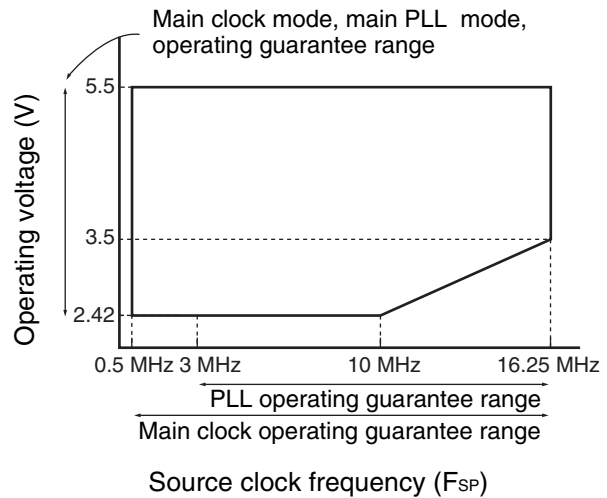
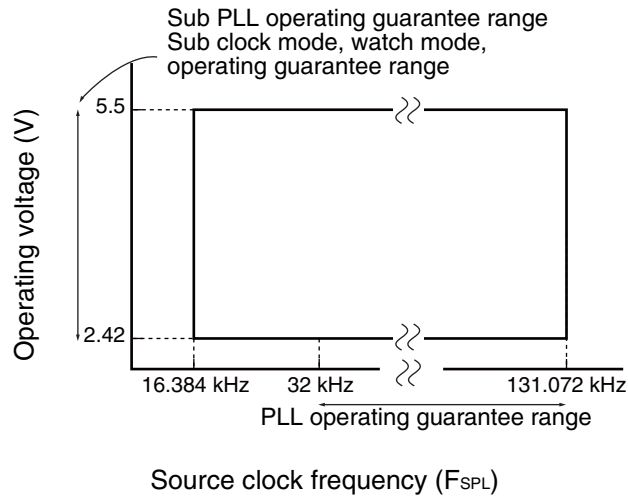


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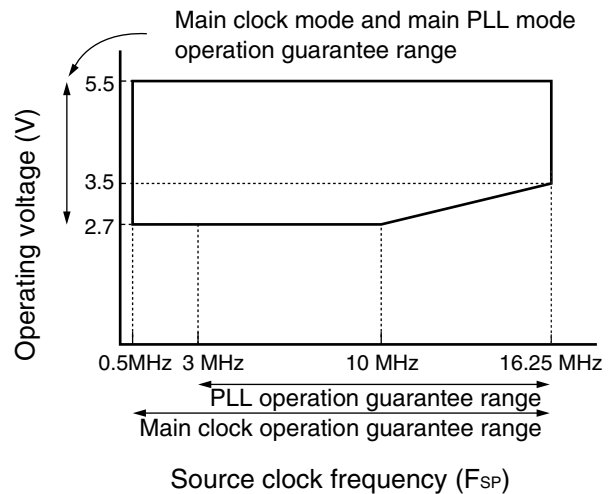
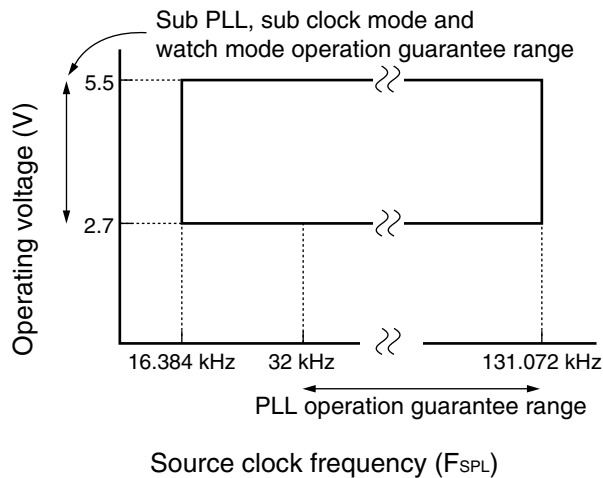
• Operating voltage – Operating frequency ($T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$)

- MB95117M/F114MS/F114NS/F114JS/F116MS/F116NS/F116JS/F118MS/F118NS/F118JS/F114MW/F114NW/
MB95F114JW/F116MW/F116NW/F116JW/F118MW/F118NW/F118JW

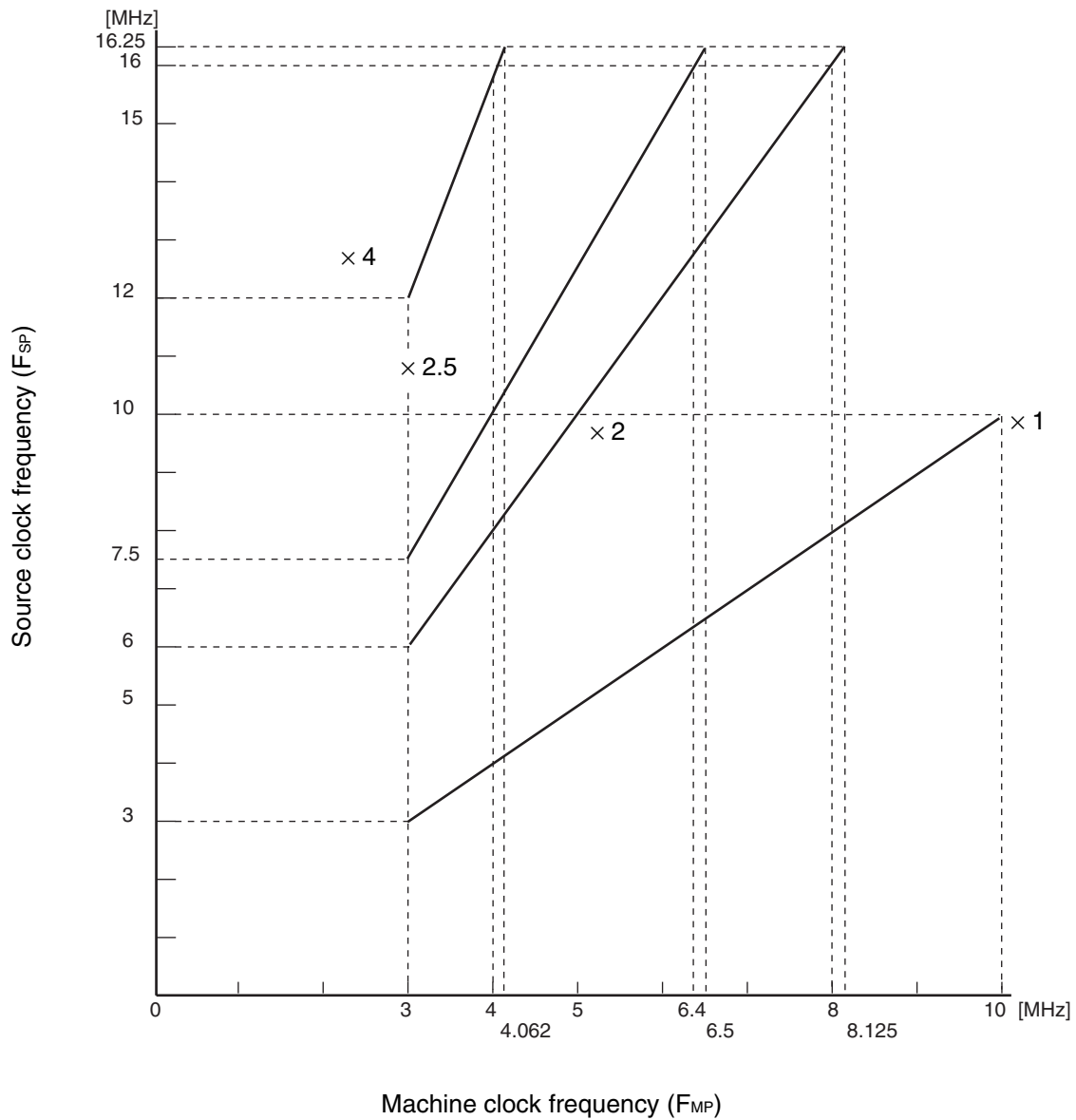


• Operating voltage – Operating frequency ($T_A = +5\text{ }^{\circ}\text{C}$ to $+35\text{ }^{\circ}\text{C}$)

- MB95FV100D-103



• Main PLL operation frequency



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(3) External Reset

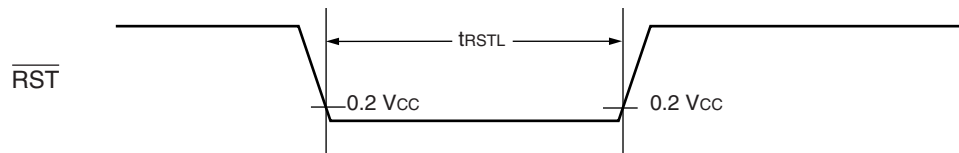
($V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+85 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
$\overline{\text{RST}}$ "L" level pulse width	t_{RSTL}	$\overline{\text{RST}}$	—	$2 t_{\text{MCLK}}^{*1}$	—	ns	At normal operating
				Oscillation time of oscillator ^{*2} + 100	—	μs	At stop mode, sub clock mode, sub sleep mode, and watch mode
				100	—	μs	At time-base timer mode

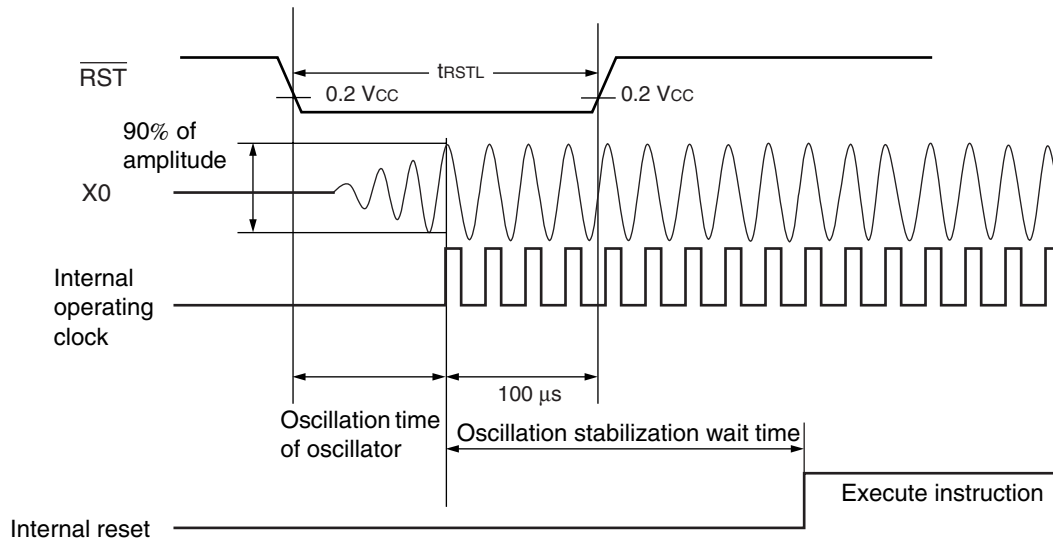
*1 : Refer to “(2) Source Clock/Machine Clock” for t_{MCLK} .

*2 : Oscillation start time of oscillator is the time that the amplitude reaches 90 %. In the crystal oscillator, the oscillation time is between several ms and tens of ms. In ceramic oscillators, the oscillation time is between hundreds of μs and several ms. In the external clock, the oscillation time is 0 ms.

- At normal operating



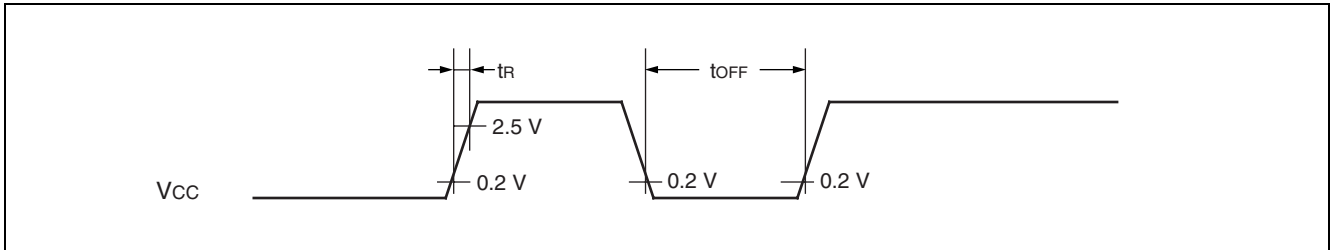
- At stop mode, sub clock mode, sub sleep mode, and watch mode, and power-on



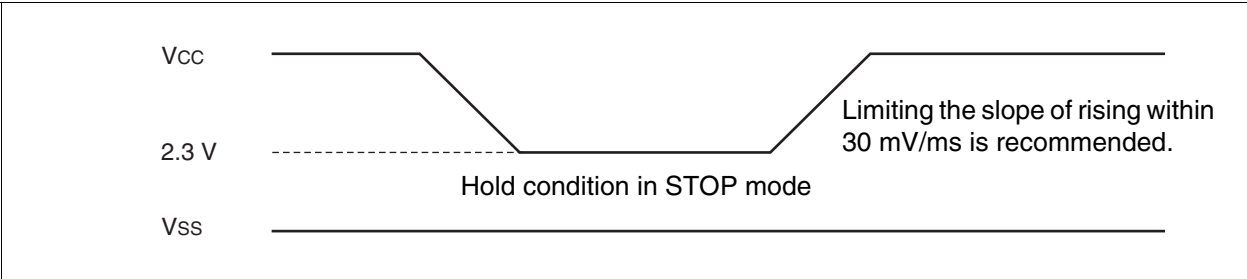
(4) Power-on Reset

(AVss = Vss = 0.0 V, TA = - 40 °C to + 85 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Power supply rising time	tR	VCC	—	—	50	ms	Waiting time until power-on
Power supply cutoff time	tOFF			1	—	ms	



Note : Sudden change of power supply voltage may activate the power-on reset function. When changing power supply voltages during operation, set the slope of rising within 30 mV/ms as shown below.



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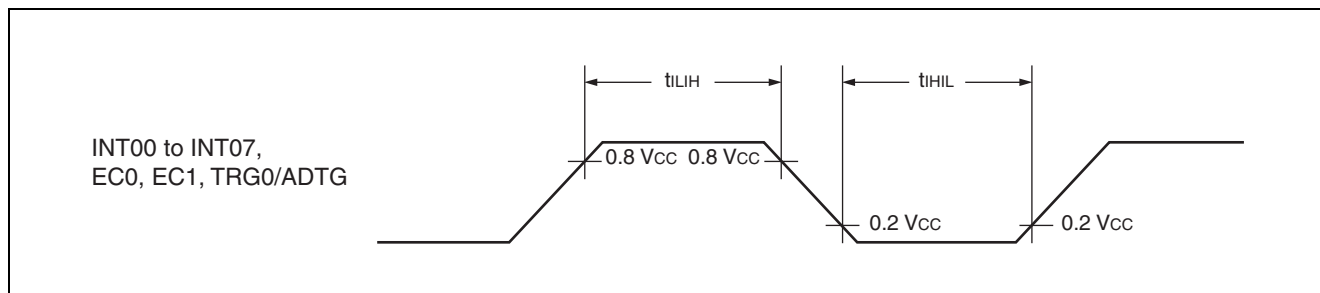
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(5) Peripheral Input Timing

($V_{CC} = 5.0\text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Condi- tions	Pin name	Value		Unit
				Min	Max	
Peripheral input "H" pulse width	t_{LIH}	—	INT00 to INT07, EC0, EC1, TRG0/ADTG	$2\ t_{\text{MCLK}}^*$	—	ns
Peripheral input "L" pulse width	t_{HIL}			$2\ t_{\text{MCLK}}^*$	—	ns

* : Refer to “ (2) Source Clock/Machine Clock” for t_{MCLK} .



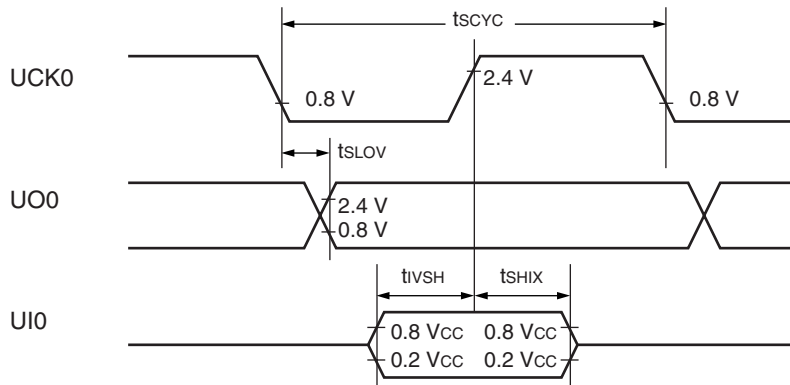
(6) UART/SIO, Serial I/O Timing

($V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0 \text{ V}$, $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$)

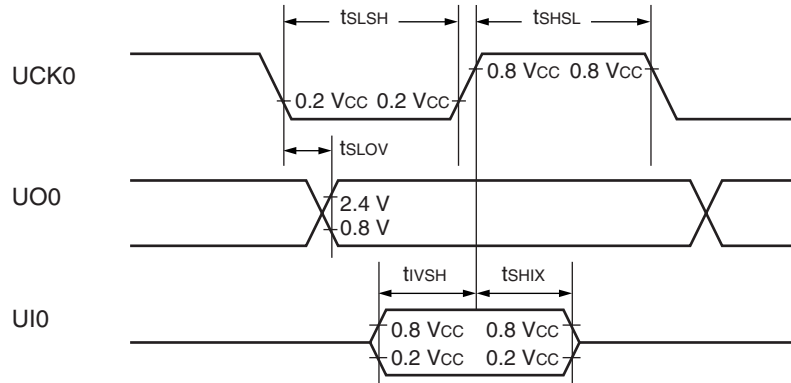
Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t_{SCYC}	UCK0	Internal clock operation Output pin: $C_L = 80 \text{ pF} + 1\text{TTL}$.	$4 t_{MCLK}^*$	—	ns
UCK $\downarrow \rightarrow$ UO time	t_{SLOV}	UCK0, UO0		-190	+190	ns
Valid UI $\rightarrow$ UCK $\uparrow$	t_{IVSH}	UCK0, UI0		$2 t_{MCLK}^*$	—	ns
UCK $\uparrow \rightarrow$ valid UI hold time	t_{SHIX}	UCK0, UI0		$2 t_{MCLK}^*$	—	ns
Serial clock "H" pulse width	t_{SHSL}	UCK0	External clock operation Output pin: $C_L = 80 \text{ pF} + 1\text{TTL}$.	$4 t_{MCLK}^*$	—	ns
Serial clock "L" pulse width	t_{SLSH}	UCK0		$4 t_{MCLK}^*$	—	ns
UCK $\downarrow \rightarrow$ UO time	t_{SLOV}	UCK0, UO0		—	190	ns
Valid UI $\rightarrow$ UCK $\uparrow$	t_{IVSH}	UCK0, UI0		$2 t_{MCLK}^*$	—	ns
UCK $\uparrow \rightarrow$ valid UI hold time	t_{SHIX}	UCK0, UI0		$2 t_{MCLK}^*$	—	ns

* : Refer to "(2) Source Clock/Machine Clock" for t_{MCLK} .

• Internal shift clock mode



• External shift clock mode



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(7) LIN-UART Timing

Sampling at the rising edge of sampling clock^{*1} and prohibited serial clock delay^{*2}

(ESCR register : SCES bit = 0, ECCR register : SCDE bit = 0)

(V_{CC} = 5.0 V ± 10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

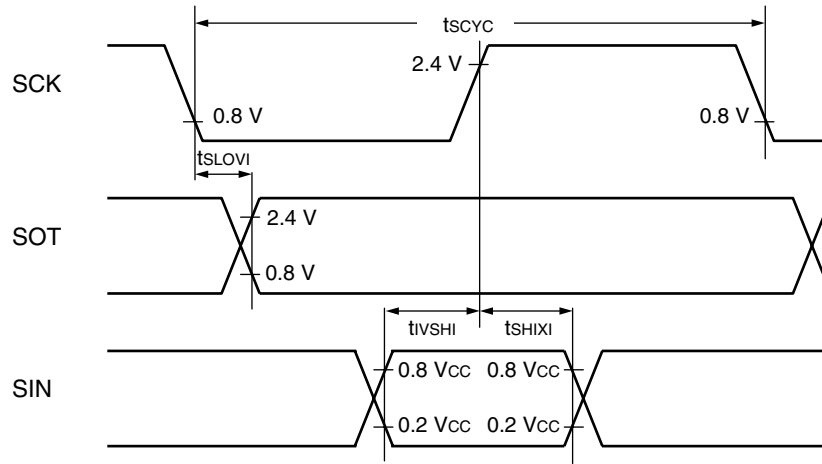
Parameter	Sym- bol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operation output pin : C _L = 80 pF + 1 TTL.	5 t _{MCLK} ^{*3}	—	ns
SCK ↓ → SOT delay time	t _{SLOVI}	SCK, SOT		-95	+ 95	ns
Valid SIN → SCK ↑	t _{IVSHI}	SCK, SIN		t _{MCLK} ^{*3} + 190	—	ns
SCK ↑ → valid SIN hold time	t _{SHIXI}	SCK, SIN		0	—	ns
Serial clock "L" pulse width	t _{SLSH}	SCK	External clock operation output pin : C _L = 80 pF + 1 TTL.	3 t _{MCLK} ^{*3} - t _R	—	ns
Serial clock "H" pulse width	t _{SHSL}	SCK		t _{MCLK} ^{*3} + 95	—	ns
SCK ↓ → SOT delay time	t _{SLOVE}	SCK, SOT		—	2 t _{MCLK} ^{*3} + 95	ns
Valid SIN → SCK ↑	t _{IVSHE}	SCK, SIN		190	—	ns
SCK ↑ → valid SIN hold time	t _{SHIXE}	SCK, SIN		t _{MCLK} ^{*3} + 95	—	ns
SCK fall time	t _F	SCK		—	10	ns
SCK rise time	t _R	SCK		—	10	ns

*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

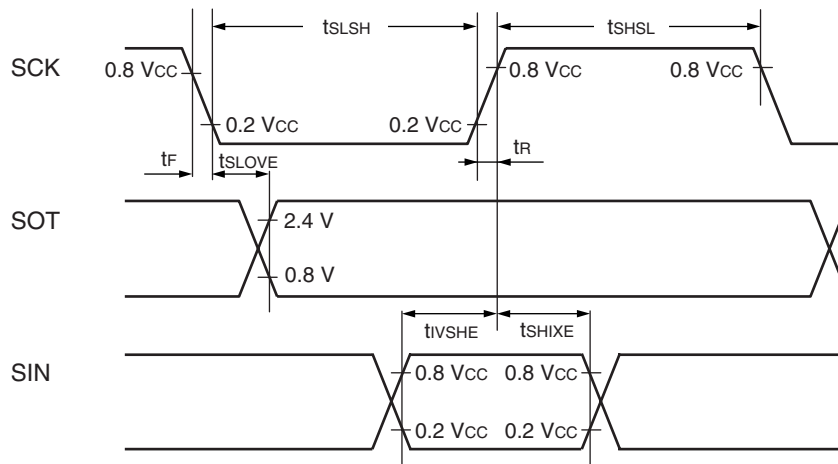
*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

*3 : Refer to " (2) Source Clock/Machine Clock" for t_{MCLK}.

- Internal shift clock mode



- External shift clock mode



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Sampling at the falling edge of sampling clock*¹ and prohibited serial clock delay*²

(ESCR register : SCES bit = 1, ECCR register : SCDE bit = 0)

(V_{CC} = 5.0 V ± 10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

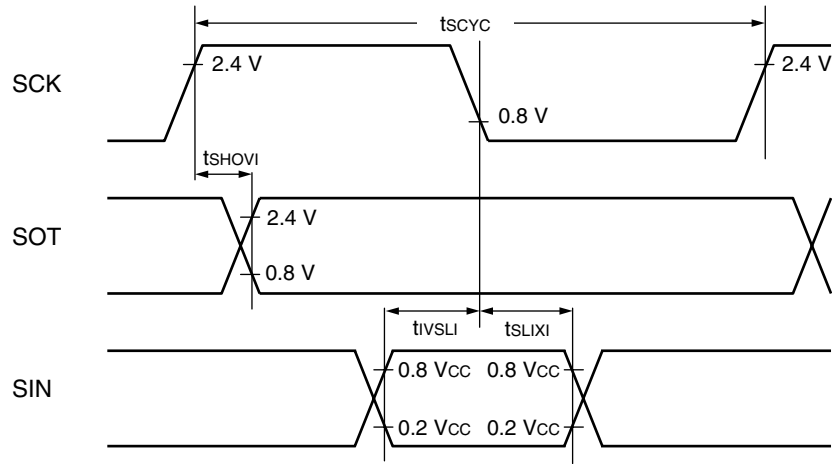
Parameter	Sym- bol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operation output pin : C _L = 80 pF + 1 TTL.	5 t _{MCLK} * ³	—	ns
SCK ↑ → SOT delay time	t _{SHOVI}	SCK, SOT		-95	+ 95	ns
Valid SIN → SCK ↓	t _{IVSLI}	SCK, SIN		t _{MCLK} * ³ + 190	—	ns
SCK ↓ → valid SIN hold time	t _{SLIXI}	SCK, SIN		0	—	ns
Serial clock "H" pulse width	t _{SHSL}	SCK	External clock operation output pin : C _L = 80 pF + 1 TTL.	3 t _{MCLK} * ³ - t _R	—	ns
Serial clock "L" pulse width	t _{SLSH}	SCK		t _{MCLK} * ³ + 95	—	ns
SCK ↑ → SOT delay time	t _{SHOVE}	SCK, SOT		—	2 t _{MCLK} * ³ + 95	ns
Valid SIN → SCK ↓	t _{IVSLE}	SCK, SIN		190	—	ns
SCK ↓ → valid SIN hold time	t _{SLIXE}	SCK, SIN		t _{MCLK} * ³ + 95	—	ns
SCK fall time	t _F	SCK		—	10	ns
SCK rise time	t _R	SCK		—	10	ns

*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

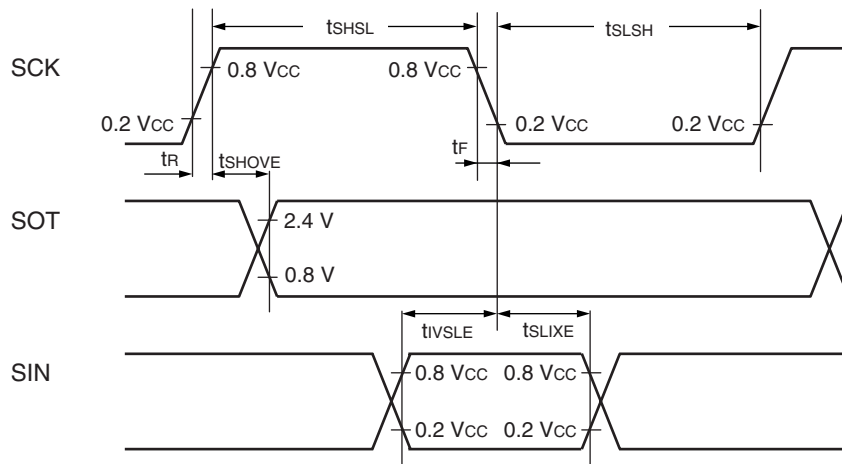
*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

*3 : Refer to “ (2) Source Clock/Machine Clock” for t_{MCLK}.

- Internal shift clock mode



- External shift clock mode



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Sampling at the rising edge of sampling clock^{*1} and enabled serial clock delay^{*2}

(ESCR register : SCES bit = 0, ECCR register : SCDE bit = 1)

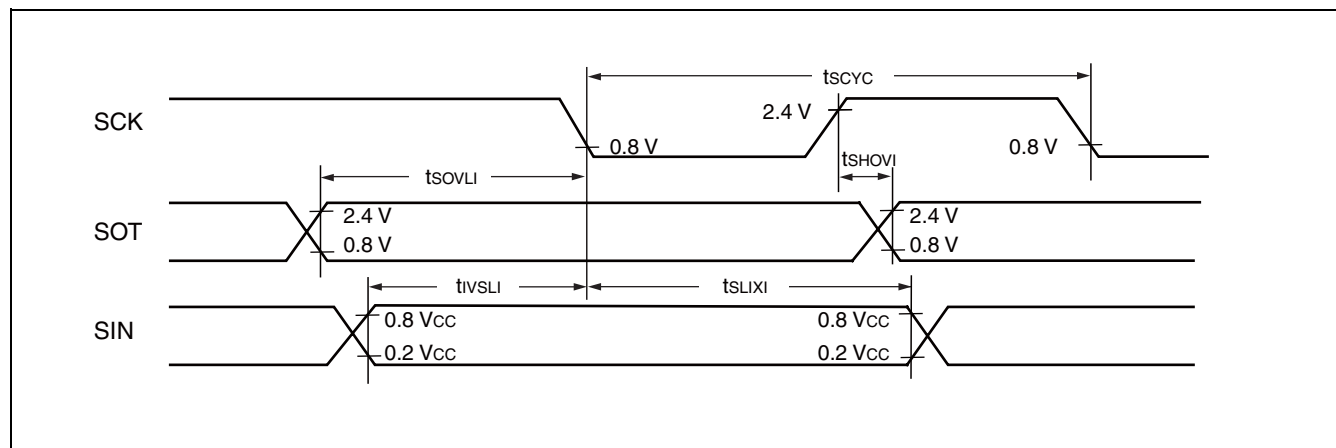
(V_{CC} = 5.0 V ± 10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to + 85 °C)

Parameter	Sym- bol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operation output pin : C _L = 80 pF + 1 TTL.	5 t _{MCLK} ^{*3}	—	ns
SCK ↑ → SOT delay time	t _{SHOVI}	SCK, SOT		-95	+ 95	ns
Valid SIN → SCK ↓	t _{IVSLI}	SCK, SIN		t _{MCLK} ^{*3} + 190	—	ns
SCK ↓ → valid SIN hold time	t _{SLIXI}	SCK, SIN		0	—	ns
SOT → SCK ↓ delay time	t _{SOVLI}	SCK, SOT		—	4 t _{MCLK} ^{*3}	ns

*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

*3 : Refer to “(2) Source Clock/Machine Clock” for t_{MCLK}.



Sampling at the falling edge of sampling clock*¹ and enabled serial clock delay*²

(ESCR register : SCES bit = 1, ECCR register : SCDE bit = 1)

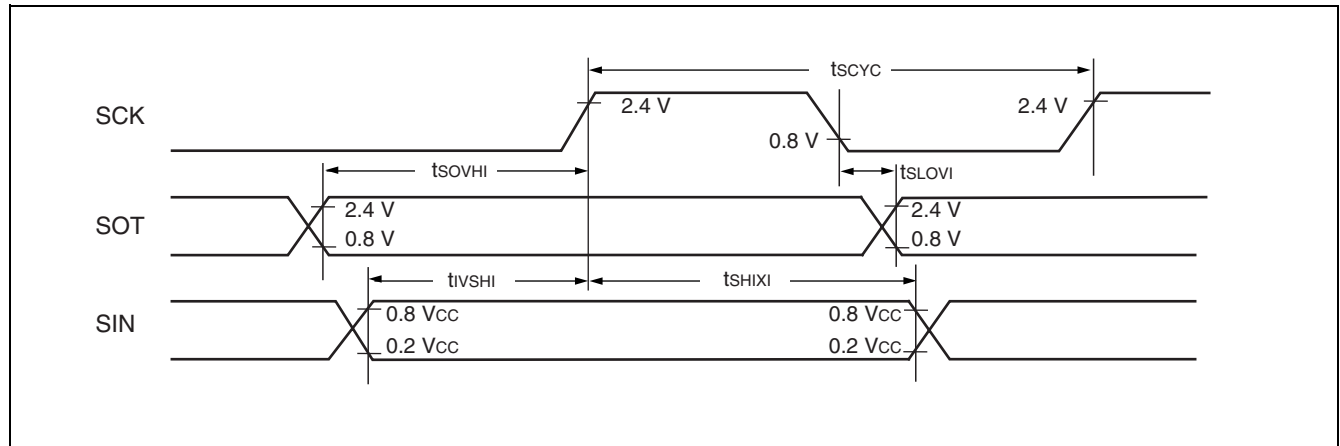
(V_{CC} = 5.0 V ± 10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to +85 °C)

Parameter	Symbol	Pin name	Conditions	Value		Unit
				Min	Max	
Serial clock cycle time	t _{SCYC}	SCK	Internal clock operating output pin : C _L = 80 pF + 1 TTL.	5 t _{MCLK} * ³	—	ns
SCK ↓ → SOT delay time	t _{SLOVI}	SCK, SOT		-95	+95	ns
Valid SIN → SCK ↑	t _{IVSHI}	SCK, SIN		t _{MCLK} * ³ + 190	—	ns
SCK ↑ → valid SIN hold time	t _{SHIXI}	SCK, SIN		0	—	ns
SOT → SCK ↑ delay time	t _{SOVHI}	SCK, SOT		—	4 t _{MCLK} * ³	ns

*1 : Provide switch function whether sampling of reception data is performed at rising edge or falling edge of the serial clock.

*2 : Serial clock delay function is used to delay half clock for the output signal of serial clock.

*3 : Refer to “(2) Source Clock/Machine Clock” for t_{MCLK}.



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(8) I²C Timing

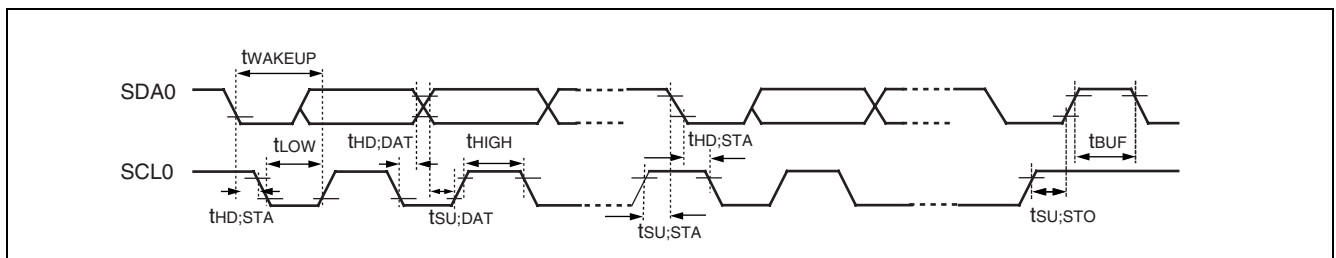
(V_{CC} = 5.0 V ± 10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to +85 °C)

Parameter	Symbol	Pin name	Conditions	Value				Unit
				Standard mode		Fast mode		
				Min	Max	Min	Max	
SCL clock frequency	f _{SCL}	SCL0	R = 1.7 kΩ, C = 50 pF*1	0	100	0	400	kHz
(Repeat) Start condition hold time SDA ↓ → SCL ↓	t _{HD;STA}	SCL0 SDA0		4.0	—	0.6	—	μs
SCL clock “L” width	t _{LOW}	SCL0		4.7	—	1.3	—	μs
SCL clock “H” width	t _{HIGH}	SCL0		4.0	—	0.6	—	μs
(Repeat) Start condition setup time SCL ↑ → SDA ↓	t _{SU;STA}	SCL0 SDA0		4.7	—	0.6	—	μs
Data hold time SCL ↓ → SDA ↓ ↑	t _{HD;DAT}	SCL0 SDA0		0	3.45*2	0	0.9*3	μs
Data setup time SDA ↓ ↑ → SCL ↑	t _{SU;DAT}	SCL0 SDA0		0.25	—	0.1	—	μs
Stop condition setup time SCL ↑ → SDA ↑	t _{SU;STO}	SCL0 SDA0		4	—	0.6	—	μs
Bus free time between stop condition and start condition	t _{BUF}	SCL0 SDA0		4.7	—	1.3	—	μs

*1 : R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

*2 : The maximum t_{HD;DAT} have only to be met if the device dose not stretch the "L" width (t_{LOW}) of the SCL signal.

*3 : A fast-mode I²C-bus device can be used in a standard-mode I²C-bus system, but the requirement
t_{SU;DAT} ≥ 250 ns must then be met.



(V_{CC} = 5.0 V ± 10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40 °C to +85 °C)

Parameter	Symbol	Pin name	Conditions	Value*2		Unit	Remarks
				Min	Max		
SCL clock "L" width	t _{LOW}	SCL0	R = 1.7 kΩ, C = 50 pF*1	$(2 + nm / 2) t_{MCLK} - 20$	—	ns	Master mode
SCL clock "H" width	t _{HIGH}	SCL0		$(nm / 2) t_{MCLK} - 20$	$(nm / 2) t_{MCLK} + 20$	ns	Master mode
Start condition hold time	t _{HD;STA}	SCL0 SDA0		$(-1 + nm / 2) t_{MCLK} - 20$	$(-1 + nm) t_{MCLK} + 20$	ns	Master mode Maximum value is applied when m, n = 1, 8. Otherwise, the minimum value is applied.
Stop condition setup time	t _{SU;STO}	SCL0 SDA0		$(1 + nm / 2) t_{MCLK} - 20$	$(1 + nm / 2) t_{MCLK} + 20$	ns	Master mode
Start condition setup time	t _{SU;STA}	SCL0 SDA0		$(1 + nm / 2) t_{MCLK} - 20$	$(1 + nm / 2) t_{MCLK} + 20$	ns	Master mode
Bus free time between stop condition and start condition	t _{BUF}	SCL0 SDA0		$(2 nm + 4) t_{MCLK} - 20$	—	ns	
Data hold time	t _{HD;DAT}	SCL0 SDA0		$3 t_{MCLK} - 20$	—	ns	Master mode
Data setup time	t _{SU;DAT}	SCL0 SDA0		$(-2 + nm / 2) t_{MCLK} - 20$	$(-1 + nm / 2) t_{MCLK} + 20$	ns	Master mode When assuming that "L" of SCL is not extended, the minimum value is applied to first bit of continuous data. Otherwise, the maximum value is applied.
Setup time between clearing interrupt and SCL rising	t _{SU;INT}	SCL0		$(nm / 2) t_{MCLK} - 20$	$(1 + nm / 2) t_{MCLK} + 20$	ns	Minimum value is applied to interrupt at 9th SCL↓. Maximum value is applied to interrupt at 8th SCL↓.
SCL clock "L" width	t _{LOW}	SCL0		$4 t_{MCLK} - 20$	—	ns	At reception
SCL clock "H" width	t _{HIGH}	SCL0		$4 t_{MCLK} - 20$	—	ns	At reception
Start condition detection	t _{HD;STA}	SCL0 SDA0		$2 t_{MCLK} - 20$	—	ns	Undetected when 1 t _{MCLK} is used at reception
Stop condition detection	t _{SU;STO}	SCL0 SDA0		$2 t_{MCLK} - 20$	—	ns	Undetected when 1 t _{MCLK} is used at reception
Restart condition detection condition	t _{SU;STA}	SCL0 SDA0		$2 t_{MCLK} - 20$	—	ns	Undetected when 1 t _{MCLK} is used at reception
Bus free time	t _{BUF}	SCL0 SDA0		$2 t_{MCLK} - 20$	—	ns	At reception
Data hold time	t _{HD;DAT}	SCL0 SDA0		$2 t_{MCLK} - 20$	—	ns	At slave transmission mode
Data setup time	t _{SU;DAT}	SCL0 SDA0		$t_{LOW} - 3 t_{MCLK} - 20$	—	ns	At slave transmission mode

(Continued)

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(Continued)

(Vcc = 5.0 V ± 10%, AVss = Vss = 0.0 V, TA = -40 °C to +85 °C)

Parameter	Sym- bol	Pin name	Condi- tions	Value*2		Unit	Remarks
				Min	Max		
Data hold time	t _{HD;DAT}	SCL0 SDA0	R = 1.7 kΩ, C = 50 pF*1	0	—	ns	At reception
Data setup time	t _{SU;DAT}	SCL0 SDA0		t _{MCLK} - 20	—	ns	At reception
SDA ↓ → SCL↑ (at wake-up function)	t _{WAKEUP}	SCL0 SDA0		Oscillation stabilization wait time + 2 t _{MCLK} - 20	—	ns	

*1 : R, C : Pull-up resistor and load capacitor of the SCL and SDA lines.

*2 : • Refer to “(2) Source Clock/Machine Clock” for t_{MCLK}.

- m is CS4 bit and CS3 bit (bit 4 and bit 3) of clock control register (ICCR0) .
- n is CS2 bit to CS0 bit (bit 2 to bit 0) of clock control register (ICCR0) .
- Actual timing of I²C is determined by m and n values set by the machine clock (t_{MCLK}) and CS4 to CS0 of ICCR0 register.
- Standard-mode :
m and n can be set at the range : 0.9 MHz < t_{MCLK} (machine clock) < 10 MHz.
Setting of m and n limits the machine clock that can be used below.

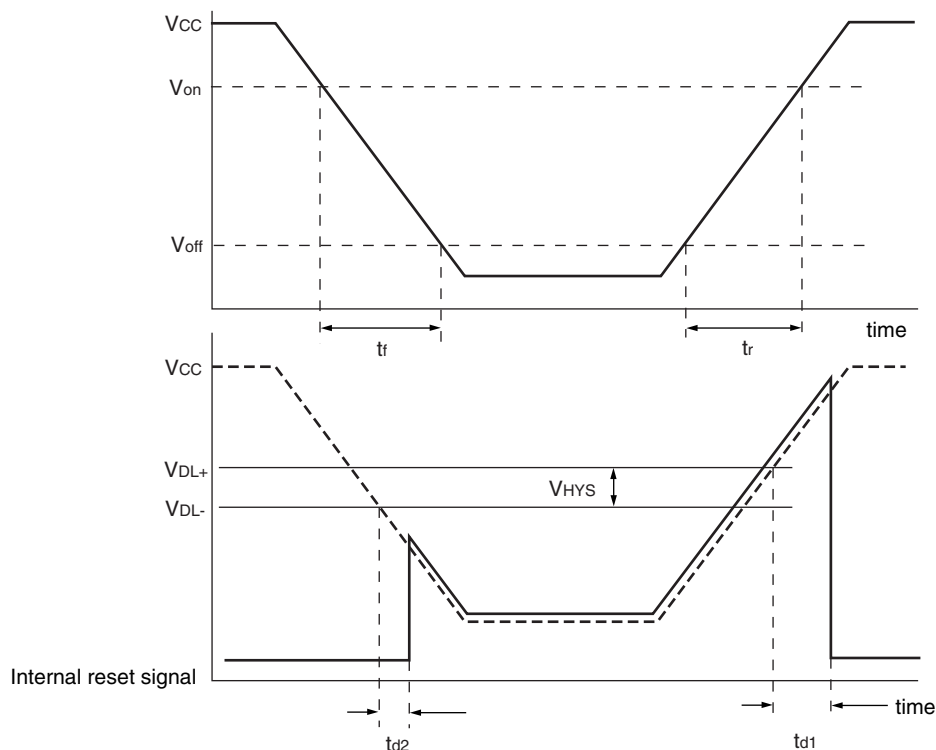
(m, n) = (1, 8)	: 0.9 MHz < t _{MCLK} ≤ 1 MHz
(m, n) = (1, 22) , (5, 4) , (6, 4) , (7, 4) , (8, 4)	: 0.9 MHz < t _{MCLK} ≤ 2 MHz
(m, n) = (1, 38) , (5, 8) , (6, 8) , (7, 8) , (8, 8)	: 0.9 MHz < t _{MCLK} ≤ 4 MHz
(m, n) = (1, 98)	: 0.9 MHz < t _{MCLK} ≤ 10 MHz
- Fast-mode :
m and n can be set at the range : 3.3 MHz < t_{MCLK} (machine clock) < 10 MHz.
Setting of m and n limits the machine clock that can be used below.

(m, n) = (1, 8)	: 3.3 MHz < t _{MCLK} ≤ 4 MHz
(m, n) = (1, 22) , (5, 4)	: 3.3 MHz < t _{MCLK} ≤ 8 MHz
(m, n) = (6, 4)	: 3.3 MHz < t _{MCLK} ≤ 10 MHz

(9) Low Voltage Detection

($V_{SS} = V_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+85 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Conditions	Value			Unit	Remarks
			Min	Typ	Max		
Release voltage	V _{DL+}	—	2.52	2.70	2.88	V	At power-supply rise
Detection voltage	V _{DL-}		2.42	2.60	2.78	V	At power-supply fall
Hysteresis width	V _{HYS}		70	100	—	mV	
Power-supply start voltage	V _{off}		—	—	2.3	V	
Power-supply end voltage	V _{on}		4.9	—	—	V	
Power-supply voltage change time (at power supply rise)	t _r		0.3	—	—	μs	Slope of power supply that reset release signal generates
			—	3000	—	μs	Slope of power supply that reset release signal generates within rating (V _{DL+})
Power-supply voltage change time (at power supply fall)	t _f		300	—	—	μs	Slope of power supply that reset detection signal generates
			—	300	—	μs	Slope of power supply that reset detection signal generates within rating (V _{DL-})
Reset release delay time	t _{d1}		—	—	400	μs	
Reset detection delay time	t _{d2}		—	—	30	μs	
Current consumption	I _{LVD}		—	38	50	μA	Current consumption for low voltage detection circuit only



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(10) Clock Supervisor Clock

($V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{SS} = V_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C}$ to $+85 \text{ }^{\circ}\text{C}$)

Parameter	Symbol	Condi- tions	Value			Unit	Remarks
			Min	Typ	Max		
Oscillation frequency	f_{OUT}	—	50	100	200	kHz	
Oscillation start time	t_{wk}		—	—	10	μs	
Current consumption	I_{CSV}		—	20	36	μs	Current consumption of built-in CR oscillator, at oscillation of 100 kHz

5. A/D Converter

(1) A/D Converter Electrical Characteristics

(AVcc = Vcc = 4.0 V to 5.5 V, AVss = Vss = 0.0 V, TA = - 40 °C to + 85 °C)

Parameter	Sym- bol	Condi- tions	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Total error			− 3.0	—	+ 3.0	LSB	
Linearity error			− 2.5	—	+ 2.5	LSB	
Differential linear error			− 1.9	—	+ 1.9	LSB	
Zero transition voltage	V _{OT}		AV _{ss} − 1.5 LSB	AV _{ss} + 0.5 LSB	AV _{ss} + 2.5 LSB	V	
Full-scale transition voltage	V _{FST}		AV _{cc} − 3.5 LSB	AV _{cc} − 1.5 LSB	AV _{cc} + 0.5 LSB	V	
Compare time	—		0.9	—	16500	μs	4.5 V ≤ AV _{cc} ≤ 5.5 V
			1.8	—	16500	μs	4.0 V ≤ AV _{cc} < 4.5 V
Sampling time	—		0.6	—	∞	μs	4.5 V ≤ AV _{cc} ≤ 5.5 V, At external impedance < 5.4 kΩ
			1.2	—	∞	μs	4.0 V ≤ AV _{cc} < 4.5 V, At external impedance < 2.4 kΩ
Analog input current	I _{AIN}		−0.3	—	+ 0.3	μA	
Analog input voltage	V _{AIN}		AV _{ss}	—	AV _{cc}	V	
Reference voltage	—		AV _{ss} + 4.0	—	AV _{cc}	V	AV _{cc} pin
Reference voltage supply current	I _R		—	600	900	μA	AV _{cc} pin, During A/D operation
	I _{RH}		—	—	5	μA	AV _{cc} pin, At stop mode

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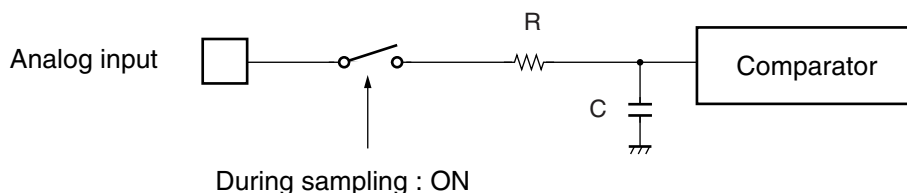
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(2) Notes on Using A/D Converter

• About the external impedance of analog input and its sampling time

A/D converter with sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, consider the relationship between the external impedance and minimum sampling time and either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. Also, if the sampling time cannot be sufficient, connect a capacitor of about 0.1 μF to the analog input pin.

• Analog input equivalent circuit

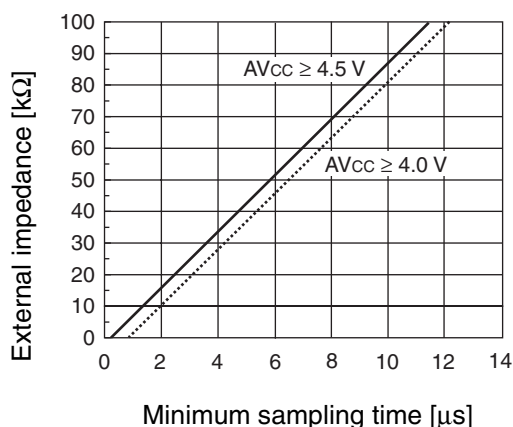


	R	C
$4.5\text{ V} \leq AV_{CC} \leq 5.5\text{ V}$	2.0 k Ω (Max)	16 pF (Max)
$4.0\text{ V} \leq AV_{CC} < 4.5\text{ V}$	8.2 k Ω (Max)	16 pF (Max)

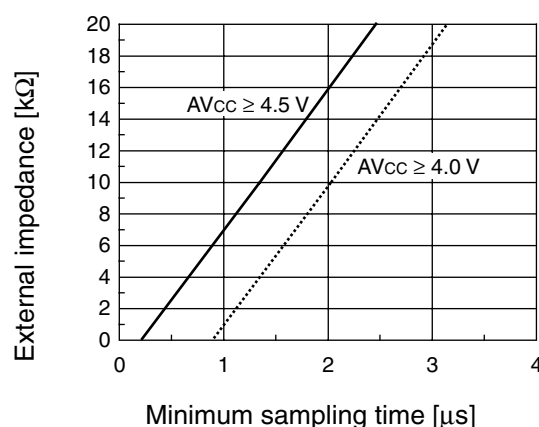
Note : The values are reference values.

• The relationship between external impedance and minimum sampling time

(External impedance = 0 k Ω to 100 k Ω)



(External impedance = 0 k Ω to 20 k Ω)



• About errors

As $|AV_{CC} - AV_{SS}|$ becomes smaller, values of relative errors grow larger.

(3) Definition of A/D Converter Terms

- Resolution

The level of analog variation that can be distinguished by the A/D converter.

When the number of bits is 10, analog voltage can be divided into $2^{10} = 1024$.

- Linearity error (unit : LSB)

The deviation between the value along a straight line connecting the zero transition point

("00 0000 0000" $\leftarrow$ "00 0000 0001") of a device and the full-scale transition point

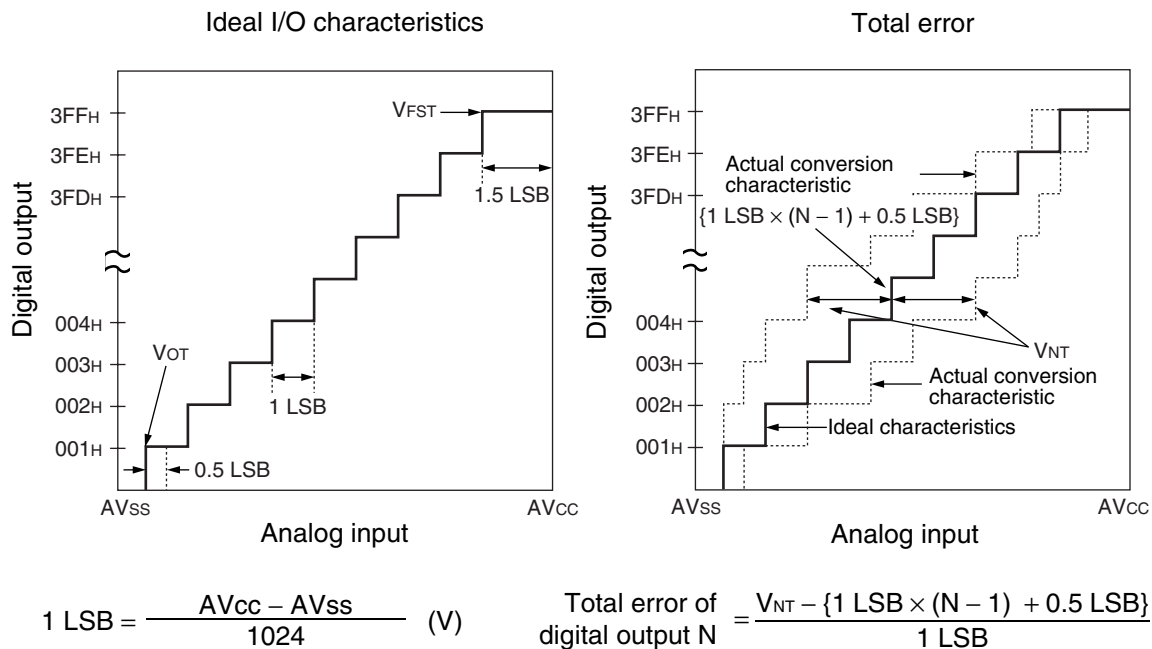
("11 1111 1111" $\leftarrow$ "11 1111 1110") compared with the actual conversion values obtained.

- Differential linear error (Unit : LSB)

Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.

- Total error (unit: LSB)

Difference between actual and theoretical values, caused by a zero transition error, full-scale transition error, linearity error, quantum error, and noise.



N : A/D converter digital output value

V_{NT} : A voltage at which digital output transits from $(N - 1)_H$ to N_H .

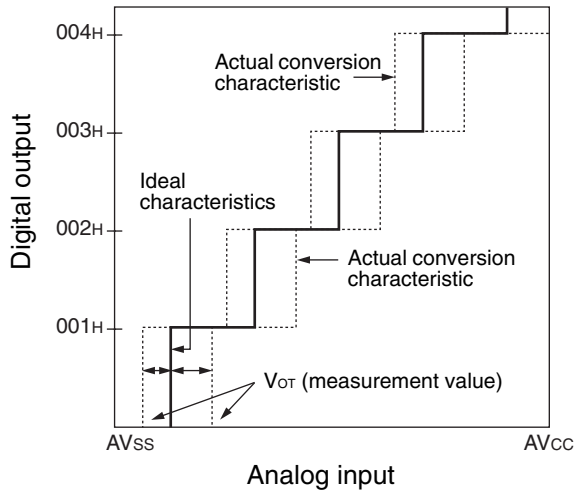
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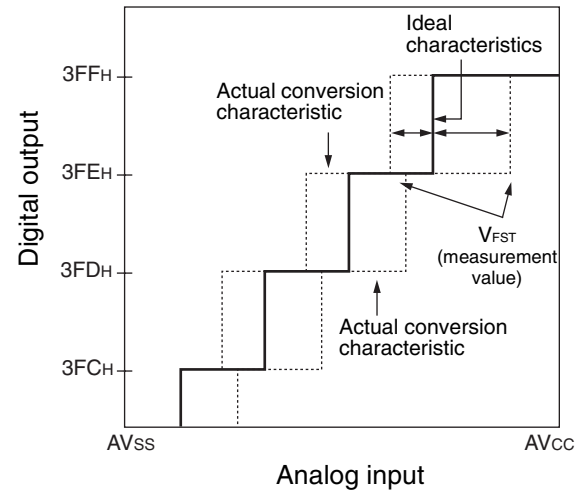
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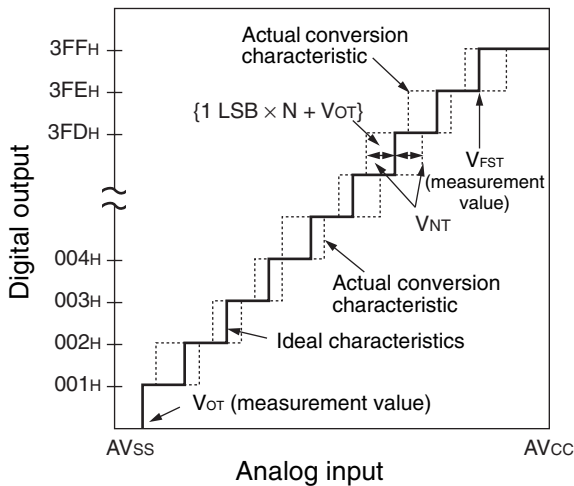
Zero transition error



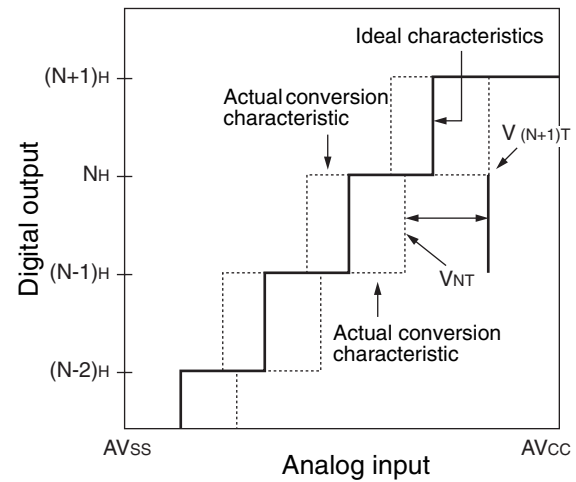
Full-scale transition error



Linearity error



Differential linear error



$$\text{Linearity error in digital output } N = \frac{V_{NT} - \{1 \text{ LSB} \times N + V_{OT}\}}{1 \text{ LSB}}$$

$$\text{Differential linear error in digital output } N = \frac{V_{(N+1)T} - V_{NT}}{1 \text{ LSB}} - 1$$

N : A/D converter digital output value

V_{NT} : A voltage at which digital output transits from $(N - 1)_H$ to N_H .

V_{OT} (Ideal value) = $AV_{SS} + 0.5 \text{ LSB [V]}$

V_{FST} (Ideal value) = $AV_{CC} - 1.5 \text{ LSB [V]}$

6. Flash Memory Program/Erase Characteristics

Parameter	Condi- tions	Value			Unit	Remarks
		Min	Typ	Max		
Sector erase time (4 Kbytes sector)	—	—	0.2* ¹	0.5* ²	s	Excludes 00 _H programming prior erasure.
Sector erase time (16 Kbytes sector)		—	0.5* ¹	7.5* ²	s	Excludes 00 _H programming prior erasure.
Byte programming time		—	32	3600	μs	Excludes system-level overhead.
Program/erase cycle		10000	—	—	cycle	
Power supply voltage at program/erase		4.5	—	5.5	V	
Flash memory data retention time		20* ³	—	—	year	Average T _A = +85 °C

*1 : T_A = + 25 °C, V_{CC} = 5.0 V, 10000 cycles

*2 : T_A = + 85 °C, V_{CC} = 4.5 V, 10000 cycles

*3 : This value comes from the technology qualification (using Arrhenius equation to translate high temperature measurements into normalized value at +85 °C) .

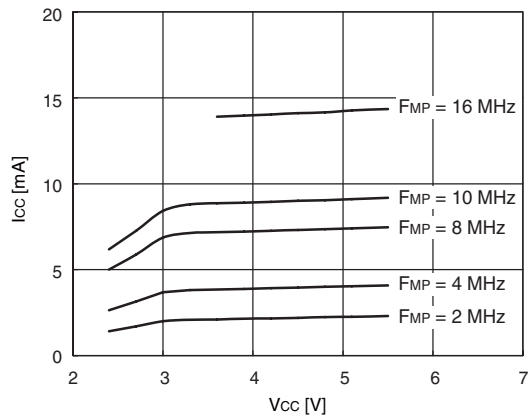
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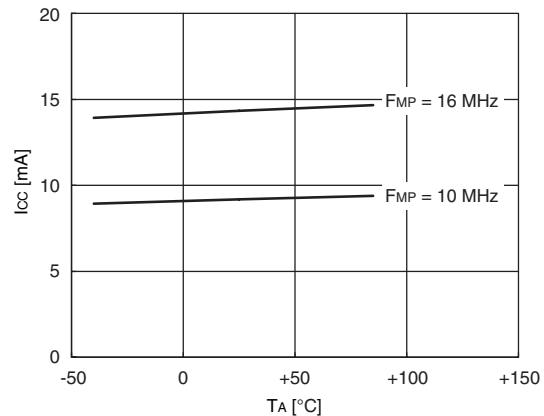
■ EXAMPLE CHARACTERISTICS

• Power supply current temperature

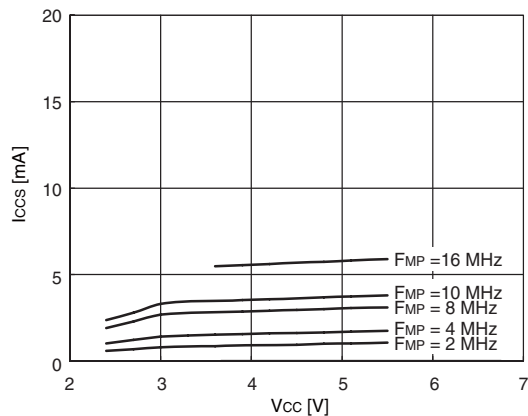
$I_{CC} - V_{CC}$
 $T_A = +25\text{ }^{\circ}\text{C}$, $F_{MP} = 2, 4, 8, 10, 16\text{ MHz}$ (divided by 2)
 Main clock mode, at external clock operating



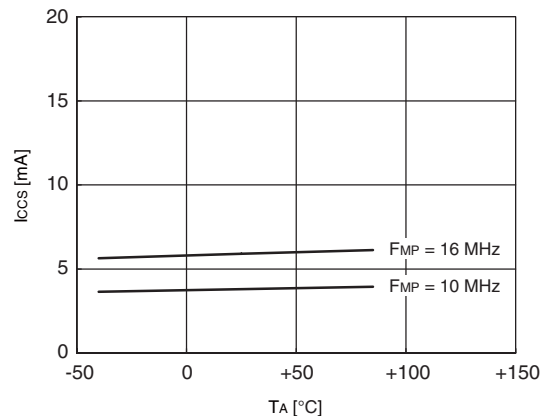
$I_{CC} - T_A$
 $V_{CC} = 5.5\text{ V}$, $F_{MP} = 10, 16\text{ MHz}$ (divided by 2)
 Main clock mode, at external clock operating



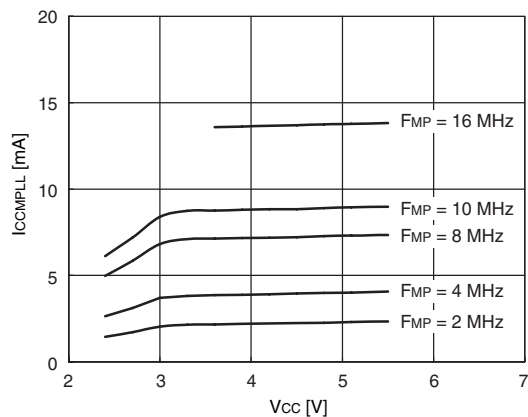
$I_{CCS} - V_{CC}$
 $T_A = +25\text{ }^{\circ}\text{C}$, $F_{MP} = 2, 4, 8, 10, 16\text{ MHz}$ (divided by 2)
 Main sleep mode, at external clock operating



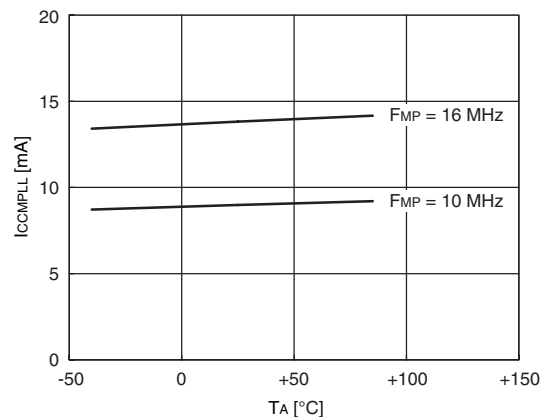
$I_{CCS} - T_A$
 $V_{CC} = 5.5\text{ V}$, $F_{MP} = 10, 16\text{ MHz}$ (divided by 2)
 Main sleep mode, at external clock operating



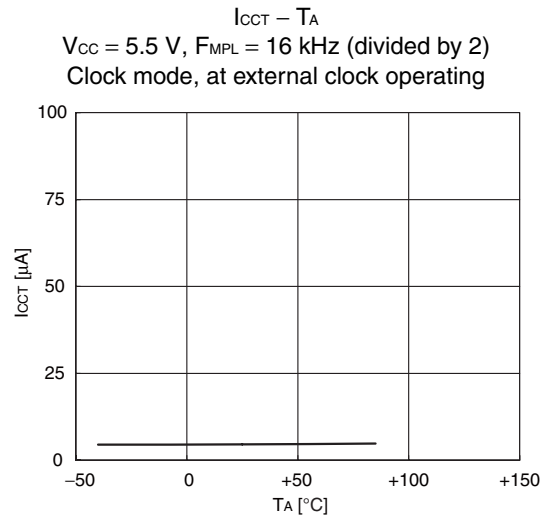
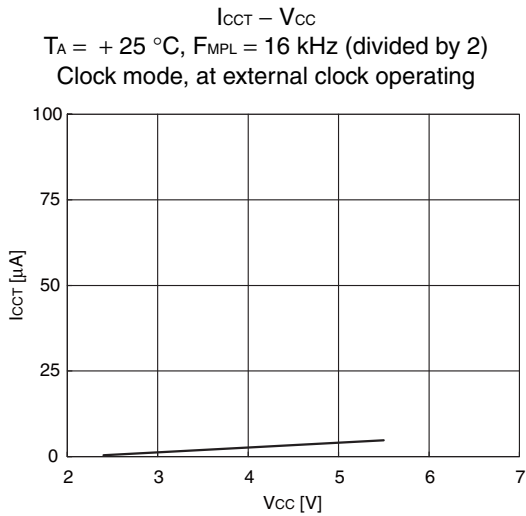
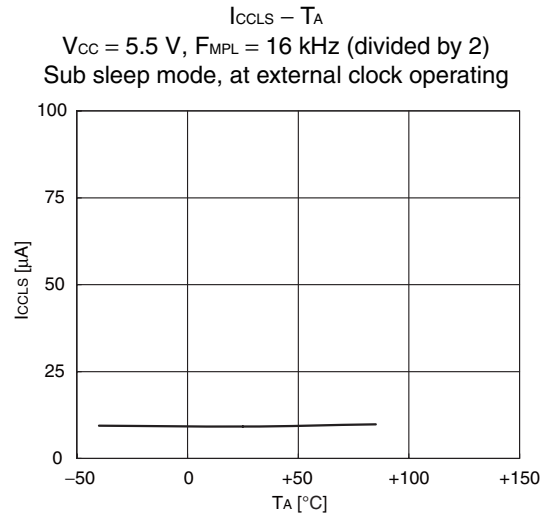
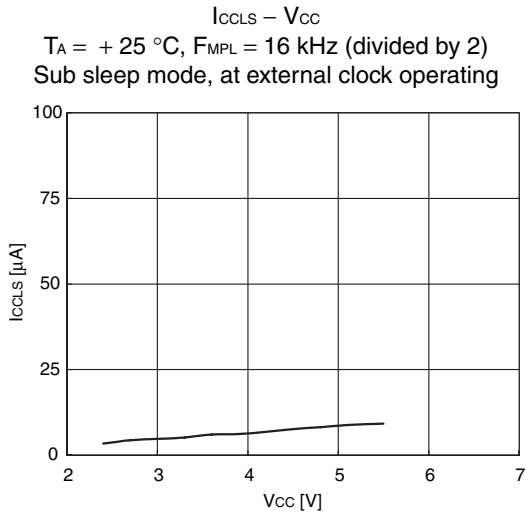
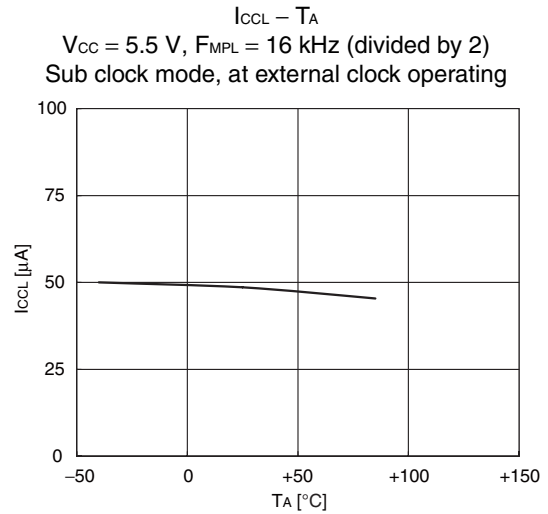
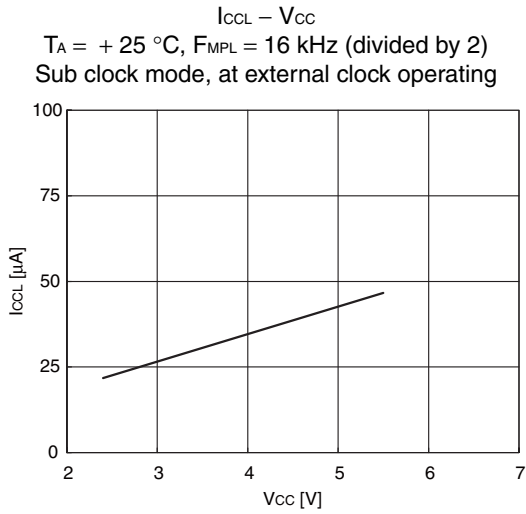
$I_{CCMPLL} - V_{CC}$
 $T_A = +25\text{ }^{\circ}\text{C}$, $F_{MP} = 2, 4, 8, 10, 16\text{ MHz}$
 (Main PLL multiplied by 2.5)
 Main PLL mode, at external clock operating



$I_{CCMPLL} - T_A$
 $V_{CC} = 5.5\text{ V}$, $F_{MP} = 10, 16\text{ MHz}$ (Main PLL multiplied by 2.5)
 Main PLL mode, at external clock operating



(Continued)

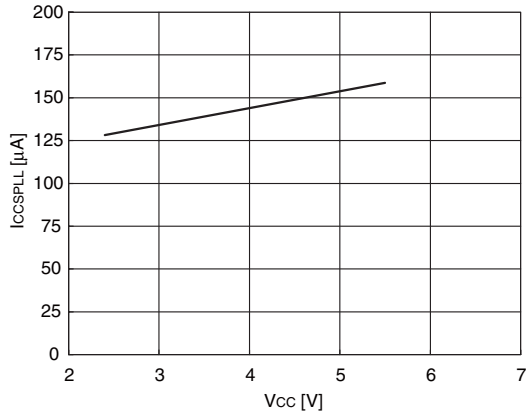


(Continued)

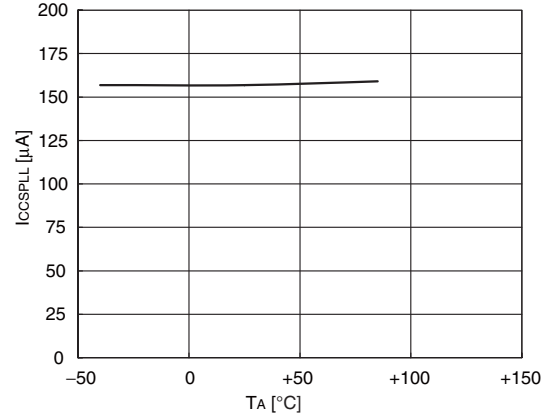
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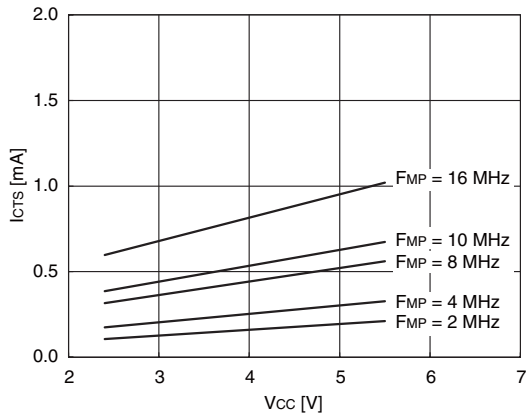
$I_{CCSPLL} - V_{CC}$
 $T_A = +25^\circ\text{C}$, $F_{MPL} = 128\text{ kHz}$ (Main PLL multiplied by 4)
 Sub PLL mode, at external clock operating



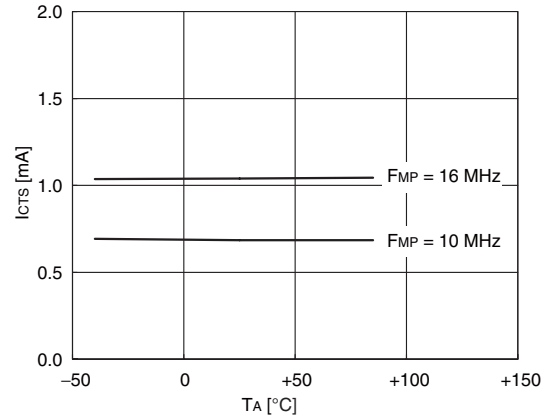
$I_{CCSPLL} - T_A$
 $V_{CC} = 5.5\text{ V}$, $F_{MPL} = 128\text{ kHz}$ (Main PLL multiplied by 4)
 Sub PLL mode, at external clock operating



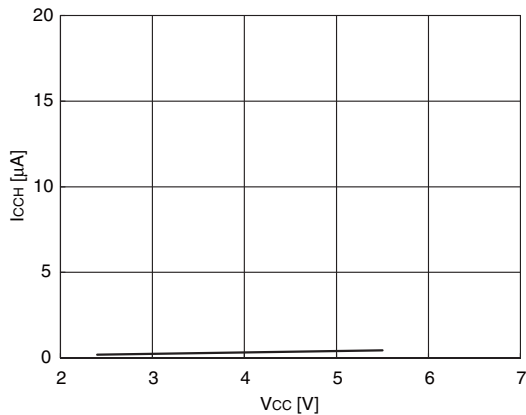
$I_{CTS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, $F_{MP} = 2, 4, 8, 10, 16\text{ MHz}$ (divided by 2)
 Time-base timer mode, at external clock operating



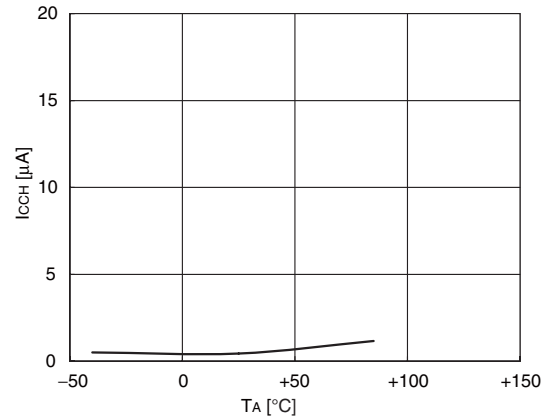
$I_{CTS} - T_A$
 $V_{CC} = 5.5\text{ V}$, $F_{MP} = 10, 16\text{ MHz}$ (divided by 2)
 Time-base timer mode, at external clock operating



$I_{CCH} - V_{CC}$
 $T_A = +25^\circ\text{C}$, $F_{MPL} = (\text{stop})$
 Sub stop mode, at external clock stopping

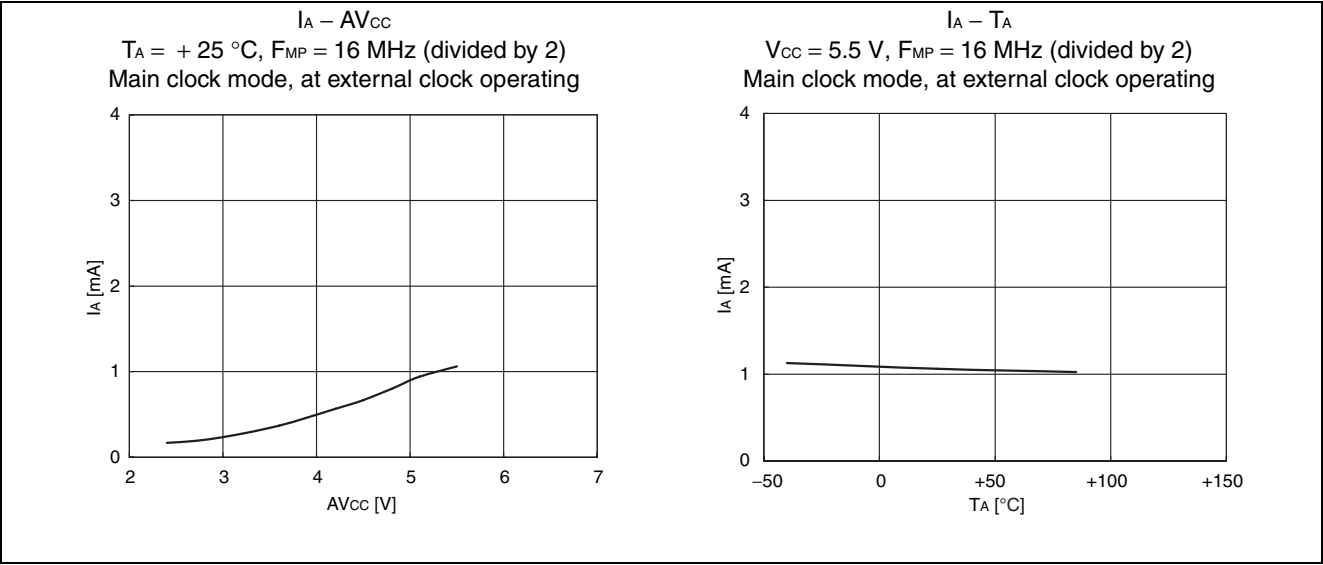


$I_{CCH} - T_A$
 $V_{CC} = 5.5\text{ V}$, $F_{MPL} = (\text{stop})$
 Sub stop mode, at external clock stopping



(Continued)

(Continued)

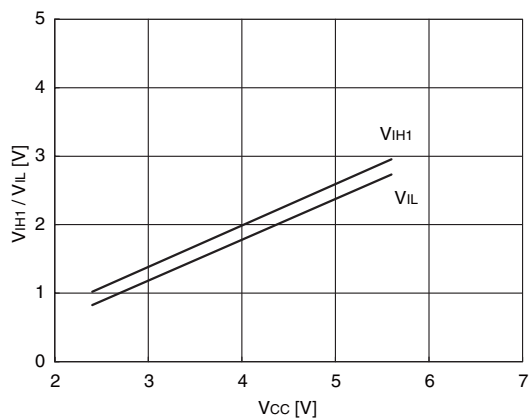


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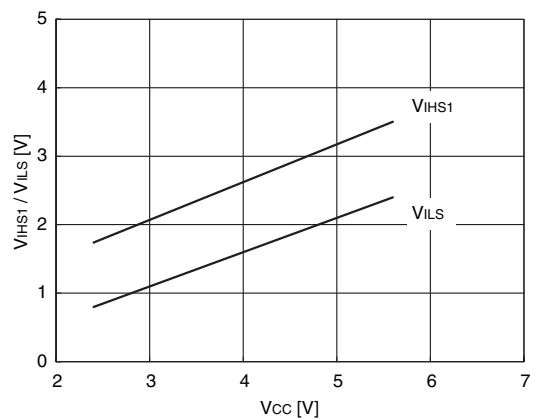
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• Input voltage

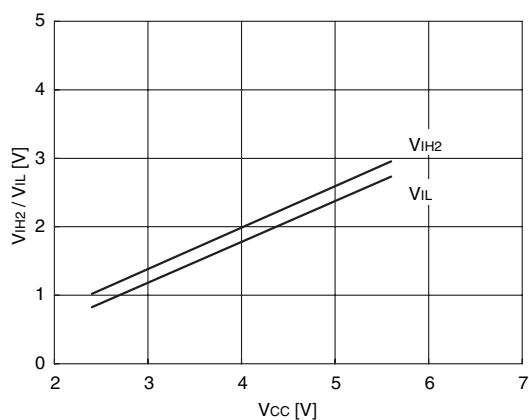
$V_{IH1} - V_{CC}$ and $V_{IL} - V_{CC}$
 $T_A = +25^\circ\text{C}$



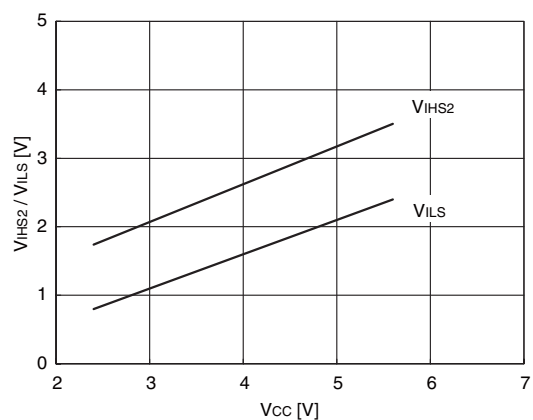
$V_{IHS1} - V_{CC}$ and $V_{ILS} - V_{CC}$
 $T_A = +25^\circ\text{C}$



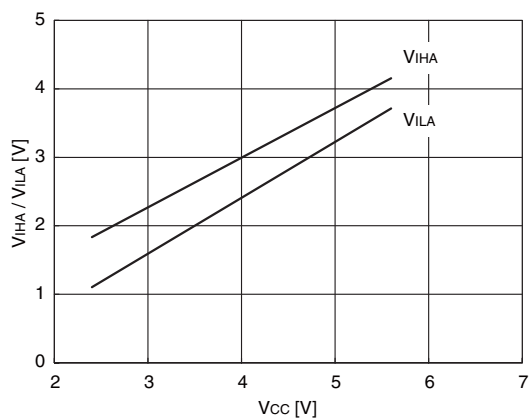
$V_{IH2} - V_{CC}$ and $V_{IL} - V_{CC}$
 $T_A = +25^\circ\text{C}$



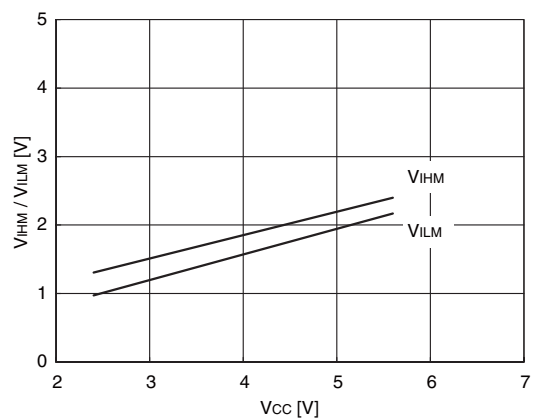
$V_{IHS2} - V_{CC}$ and $V_{ILS} - V_{CC}$
 $T_A = +25^\circ\text{C}$



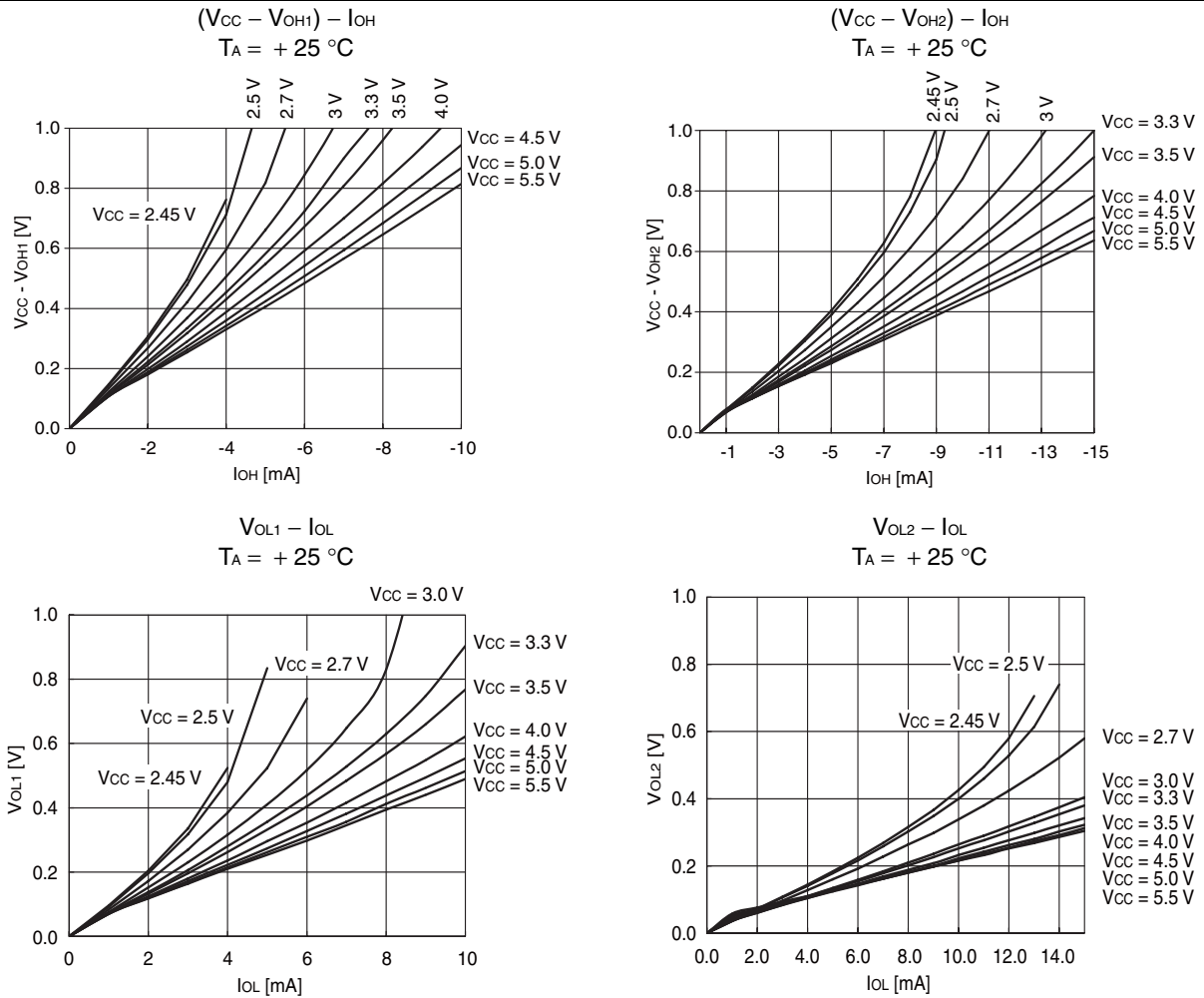
$V_{IHA} - V_{CC}$ and $V_{ILA} - V_{CC}$
 $T_A = +25^\circ\text{C}$



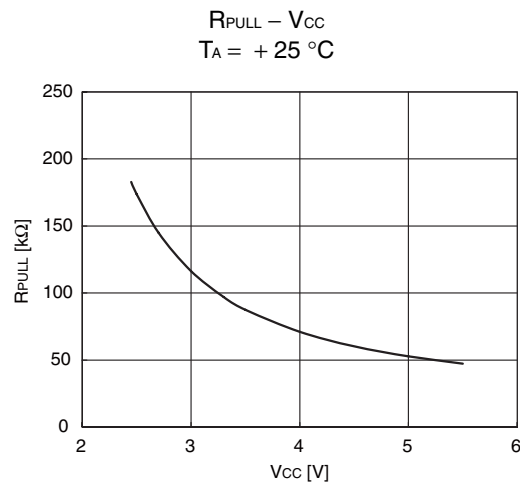
$V_{IHM} - V_{CC}$ and $V_{ILM} - V_{CC}$
 $T_A = +25^\circ\text{C}$



• Output voltage



• Pull-up



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■ MASK OPTION

No.	Part number	MB95117M	MB95F114MS/F114NS MB95F114JS MB95F116MS/F116NS MB95F116JS MB95F118MS/F118NS MB95F118JS	MB95F114MW/F114NW MB95F114JW MB95F116MW/F116NW MB95F116JW MB95F118MW/F118NW MB95F118JW	MB95FV100D-103
	Specifying procedure	Specify when ordering MASK	Setting disabled	Setting disabled	Setting disabled
1	Clock mode select • Single-system clock mode • Dual-system clock mode	Specify when ordering MASK	Single-system clock mode	Dual-system clock mode	Changing by the switch on MCU board
2	Low voltage detection reset* • With low voltage detection reset • Without low voltage detection reset	Specify when ordering MASK	Specified by part number	Specified by part number	Changing by the switch on MCU board
3	Clock supervisor* • With clock supervisor • Without clock supervisor	Specify when ordering MASK	Specified by part number	Specified by part number	Changing by the switch on MCU board
4	Reset output* • With reset output • Without reset output	Specify when ordering MASK	Specified by part number	Specified by part number	MCU board switch set as following ; • With supervisor : Without reset output • Without supervisor : With reset output
5	Oscillation stabilization wait time	Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$	Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$	Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$	Fixed to oscillation stabilization wait time of $(2^{14}-2) / F_{CH}$

* : Refer to table below about clock mode select, low voltage detection reset, clock supervisor select and reset output.

MB95110M Series

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Part number	Clock mode select	Low voltage detection reset	Clock supervisor	Reset output
MB95117M	Single-system	No	No	Yes
		Yes	No	Yes
	Dual-system	No	No	Yes
		Yes	No	Yes
MB95F114MS	Single-system	No	No	Yes
MB95F114NS		Yes	No	Yes
MB95F114JS		Yes	Yes	No
MB95F116MS		No	No	Yes
MB95F116NS		Yes	No	Yes
MB95F116JS		Yes	Yes	No
MB95F118MS		No	No	Yes
MB95F118NS		Yes	No	Yes
MB95F118JS		Yes	Yes	No
MB95F114MW	Dual-system	No	No	Yes
MB95F114NW		Yes	No	Yes
MB95F114JW		Yes	Yes	No
MB95F116MW		No	No	Yes
MB95F116NW		Yes	No	Yes
MB95F116JW		Yes	Yes	No
MB95F118MW		No	No	Yes
MB95F118NW		Yes	No	Yes
MB95F118JW		Yes	Yes	No
MB95FV100D-103	Single-system	No	No	Yes
		Yes	No	Yes
		Yes	Yes	No
	Dual-system	No	No	Yes
		Yes	No	Yes
		Yes	Yes	No

MB95110M Series

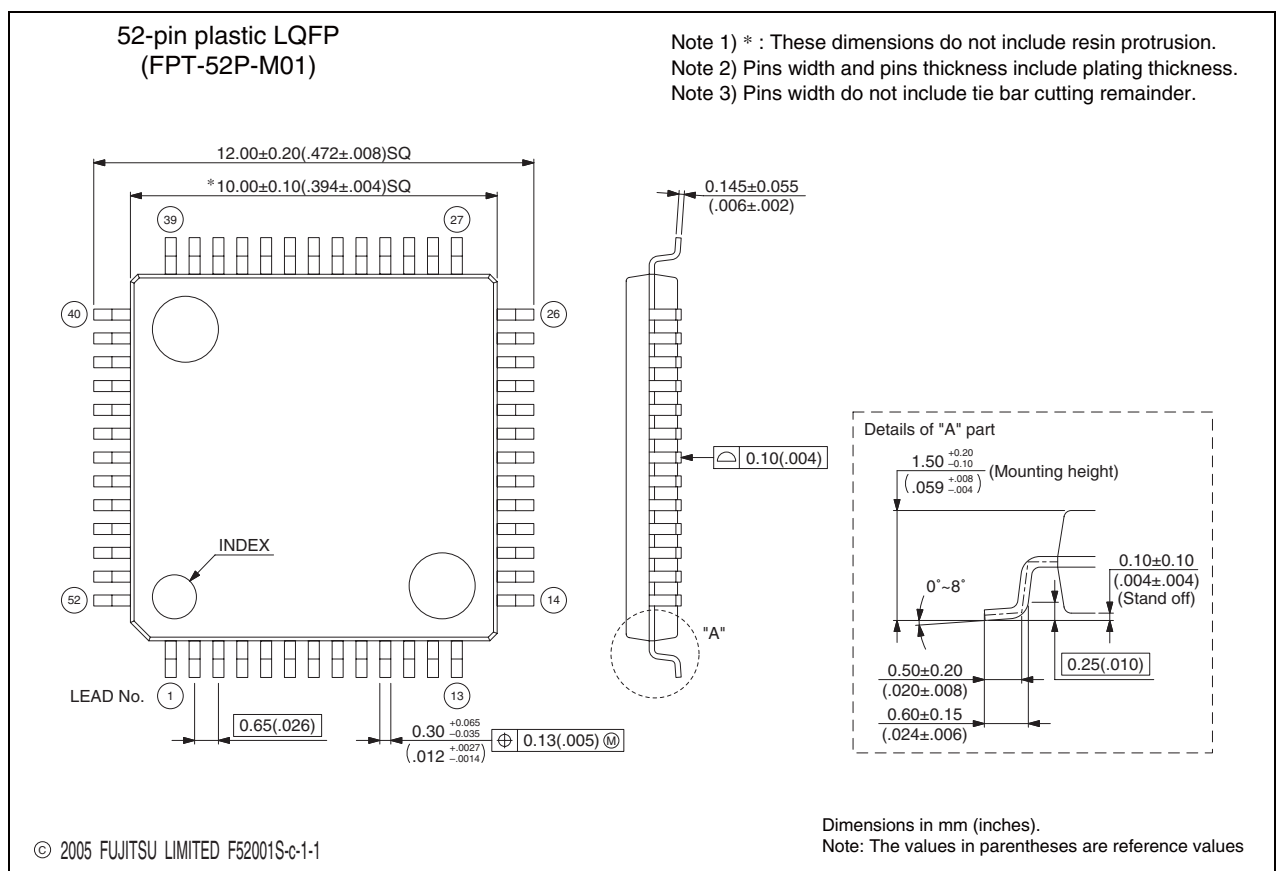
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■ ORDERING INFORMATION

Part number	Package
MB95117MPMC MB95F114MSPMC MB95F114NSPMC MB95F114JSPMC MB95F116MSPMC MB95F116NSPMC MB95F116JSPMC MB95F118MSPMC MB95F118NSPMC MB95F118JSPMC MB95F114MWPMC MB95F114NWPMC MB95F114JWPMC MB95F116MWPMC MB95F116NWPMC MB95F116JWPMC MB95F118MWPMC MB95F118NWPMC MB95F118JWPMC	52-pin plastic LQFP (FPT-52P-M01)
MB2146-303A (MB95FV100D-103PBT)	MCU board (224-pin plastic PFBGA) (BGA-224P-M08)

■ PACKAGE DIMENSION

52-pin plastic LQFP (FPT-52P-M01)	Lead pitch	0.65 mm
	Package width × package length	10.0 × 10.0 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.70 mm Max
	Code (Reference)	P-LQFP52-10×10-0.65



Please confirm the latest Package dimension by following URL.
<http://edevic.fujitsu.com/package/en-search/>

MB95110M Series

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■ MAIN CHANGES IN THIS EDITION

Page	Section	Change Results
—	—	No third edition in the DS07-12611-4E.
2	■ FEATURES	Added the description Dual operation Flash memory.
4	■ PRODUCT LINEUP	Changed the contents of Option.
6	■ PACKAGES AND CORRESPONDING PRODUCTS	Changed FPT-52P-M01 of MB95117M as follows; * (Under development) → ○ (Available).
7	■ DIFFERENCES AMONG PRODUCTS AND NOTES ON SELECTING PRODUCTS • Difference between $\overline{RST}$ and MOD Pins	Deleted as follows; “The input type of $\overline{RST}$ and MOD pins is CMOS inputs on the Flash memory product. The $\overline{RST}$ and MOD pins are hysteresis inputs on the MASK ROM product.”
11	■ I/O CIRCUIT TYPE	Changed as follows in the remarks of “Type B”. Hysteresis input only for MASK ROM product → Hysteresis input
24	■ I/O MAP	Changed as follows for R/W of Reset source register R → R/W
37	■ ELECTRICAL CHARACTERISTICS 4. AC Characteristics (1) Clock Timing	Added “Main PLL multiplied by 4” in the Clock frequency
39	(2) Source Clock/Machine Clock	- Changed in the remarks of source clock cycle time (when using main clock) Min : $F_{CH} = 16.25 \text{ MHz}$, PLL multiplied by 1 → Min : $F_{CH} = 8.125 \text{ MHz}$, PLL multiplied by 2 - Changed the footnote of *1; PLL multiplication of main clock (select from 1, 2, 2.5 multiplication) → PLL multiplication of main clock (select from 1, 2, 2.5, 4 multiplication) - Added “$\times 4$” in the Main PLL of “• Outline of clock generation block”
41		Changed the figure of • Main PLL operation frequency
62 to 67	■ EXAMPLE CHARACTERISTICS	Added the ■ EXAMPLE CHARACTERISTICS

The vertical lines marked in the left side of the page show the changes.

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